Operational Amplifiers / Comparators

High Speed with Low Voltage CMOS Operational Amplifiers

Input-Output Full Swing
BU7291G,BU7291SG,BU7255HFV,BU7255SHFV

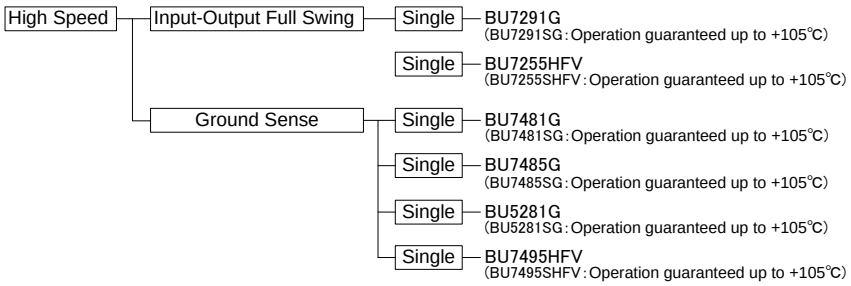
Ground sense
BU7495HFV,BU7495SHFV,BU7481G,BU7481SG
BU7485G,BU7485SG,BU5281G,BU5281SG

No.10049EAT20

●Description

Low Voltage with High Speed CMOS Op-Amp integrates one independent output full swing Op-Amps and phase compensation capacitors on a single chip. Especially, this series is operable with low voltage, low supply current, high speed and low input bias current.

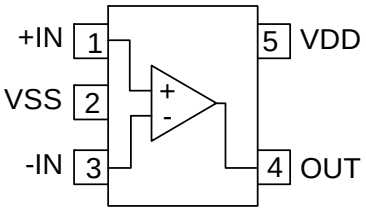
- Input-Output Full Swing
  BU7291 family, BU7255 family
- Ground sense
  BU7495 family, BU7481 family,
  BU7485 family, BU5281 family



●Features

1) Low operating supply voltage
   +2.4 [V] ~ +5.5 [V] (single supply): BU7291 family
   BU7255 family
   +1.8 [V] ~ +5.5 [V] (single supply): BU7495 family
   BU7481 family
   BU5281 family
   +3.0 [V] ~ +5.5 [V] (single supply): BU7485 family
2) High large signal voltage gain
3) Internal ESD protection
   Human body model (HBM) ±4000 [V] (Typ.)
4) Low input bias current 1[pA] (Typ.)
5) High slew rate
   3.0 [V/μs]: BU7291 family
   3.4 [V/μs]: BU7255 family
   5.0 [V/μs]: BU7495 family
   3.2 [V/μs]: BU7481 family
   2.0 [V/μs]: BU5281 family
   10.0 [V/μs]: BU7485 family

●Pin Assignments



SSOP5	HVSOF5
BU7291G BU7291SG	BU7255HFV BU7255SHFV
BU7485G BU7485SG	BU7495HFV BU7495SHFV
BU7481G BU7481SG	
BU5281G BU5281SG	

●Absolute Maximum Ratings(Ta=25[℃])

Parameter	Symbol	Ratings		Unit
		BU7291G, BU7255HFV BU7495HFV, BU7481G BU7485G, BU5281G	BU7291SG, BU7255SHFV BU7495SHFV, BU7481SG BU7485SG, BU5281SG	
Supply Voltage	VDD - VSS	+7		V
Differential Input Voltage (*1)	Vid	VDD - VSS		V
Input Common-mode Voltage Range	Vicm	(VSS - 0.3) ~ (VDD + 0.3)		V
Operating Temperature	Topr	- 40 ~ +85	- 40 ~ +105	℃
Storage Temperature	Tstg	- 55 ~ +125		℃
Maximum Junction Temperature	Tjmax	+125		℃

Note: Absolute maximum rating item indicates the condition which must not be exceeded.
Application of voltage in excess of absolute maximum rating or use out absolute maximum rated temperature environment may cause deterioration of characteristics.
(*1) The voltage difference between inverting input and non-inverting input is the differential input voltage.
Then input terminal voltage is set to more than VSS.

●Electrical characteristics: Input-Output Full Swing

○BU7291 family(Unless otherwise specified VDD=+3[V], VSS=0[V], Ta=25[℃])

Parameter	Symbol	Temperature Range	Limits			Unit	Condition
			BU7291G, BU7291SG				
			Min.	Typ.	Max.		
Input Offset Voltage (*2)	Vio	25℃	—	1	9	mV	—
Input Offset Current (*2)	Iio	25℃	—	1	—	pA	—
Input Bias Current (*2)	Ib	25℃	—	1	—	pA	—
Supply Current (*3)	IDD	25℃	—	470	800	μA	RL=∞ All Op-Amps AV=0[dB],VIN=1.5[V]
		Full range	-	—	1100		
High Level Output Voltage	VOH	25℃	VDD-0.1	—	—	V	RL=10[kΩ]
Low Level Output Voltage	VOL	25℃	—	—	VSS+0.1	V	RL=10[kΩ]
Large Signal Voltage Gain	AV	25℃	70	105	—	dB	RL=10[kΩ]
Input Common-mode Voltage Range	Vicm	25℃	0	—	3	V	VSS ~ VDD
Common-mode Rejection Ratio	CMRR	25℃	40	60	—	dB	—
Power Supply Rejection Ratio	PSRR	25℃	45	80	—	dB	—
Output Source Current (*4)	IOH	25℃	5	8	—	mA	VDD-0.4[V]
Output Sink Current (*4)	IOL	25℃	9	16	—	mA	VSS+0.4[V]
Slew Rate	SR	25℃	—	3.0	—	V/μs	CL=25[pF]
Gain Band width	FT	25℃	—	2.8	—	MHz	CL=25[pF], AV=40[dB]
Phase Margin	θ	25℃	—	50	—	°	CL=25[pF], AV=40[dB]
Total Harmonic Distortion	THD	25℃	—	0.03	—	%	VOUT=0.8[Vp-p],f=1[kHz]

(*2) Absolute value
(*3) Full range BU7291: Ta=-40[℃]~+85[℃] BU7291S: Ta=-40[℃]~+105[℃]
(*4) Under the high temperature environment, consider the power dissipation of IC when selecting the output current.
When the terminal short circuits are continuously output, the output current is reduced to climb to the temperature inside IC.

○BU7255(Unless otherwise specified VDD=+3[V], VSS=0[V], Ta=25[℃])

Parameter	Symbol	Temperature Range	Limits			Unit	Condition
			BU7255HFV, BU7255SHFV				
			Min.	Typ.	Max.		
Input Offset Voltage (*5)	Vio	25℃	—	1	9	mV	—
Input Offset Current (*5)	Iio	25℃	—	1	—	pA	—
Input Bias Current (*5)	Ib	25℃	—	1	—	pA	—
Supply Current (*6)	IDD	25℃	—	540	900	μA	RL=∞ All Op-Amps AV=0[dB],VIN=1.5[V]
		Full range	—	—	1200		
High Level Output Voltage	VOH	25℃	VDD-0.1	—	—	V	RL=10[kΩ]
Low Level Output Voltage	VOL	25℃	—	—	VSS+0.1	V	RL=10[kΩ]
Large Signal Voltage Gain	AV	25℃	60	105	—	dB	RL=10[kΩ]
Input Common-mode Voltage Range	Vicm	25℃	0	-	3	V	VSS ~ VDD
Common-mode Rejection Ratio	CMRR	25℃	40	60	—	dB	—
Power Supply Rejection Ratio	PSRR	25℃	45	80	—	dB	—
Output Source Current (*7)	IOH	25℃	2	4	—	mA	VDD - 0.4[V]
Output Sink Current (*7)	IOL	25℃	4	8	—	mA	VSS + 0.4[V]
Slew Rate	SR	25℃	—	3.4	—	V/μs	CL=25[pF]
Gain Band width	FT	25℃	—	4	—	MHz	CL=25[pF], AV=40[dB]
Phase Margin	θ	25℃	—	40	—	°	CL=25[pF], AV=40[dB]

(*5) Absolute value
(*6) Full range BU7255: Ta=-40[℃]~+85[℃] BU7255S: Ta=-40[℃]~+105[℃]
(*7) Under the high temperature environment, consider the power dissipation of IC when selecting the output current.
When the terminal short circuits are continuously output, the output current is reduced to climb to the temperature inside IC.

○BU7495 family(Unless otherwise specified VDD=+3[V], VSS=0[V], Ta=25[℃])

Parameter	Symbol	Temperature Range	Limits			Unit	Condition
			BU7495HFV, BU7495SHFV				
			Min.	Typ.	Max.		
Input Offset Voltage (*8)	Vio	25℃	—	1	6	mV	—
Input Offset Current (*8)	Iio	25℃	—	1	—	pA	—
Input Bias Current (*8)	Ib	25℃	—	1	—	pA	—
Supply Current (*9)	IDD	25℃	—	650	1150	μA	RL=∞ All Op-Amps AV=0[dB],VIN=0.9[V]
		Full range	—	—	1350		
High Level Output Voltage	VOH	25℃	VDD-0.1	—	—	V	RL=10[kΩ]
Low Level Output Voltage	VOL	25℃	-	-	VSS+0.1	V	RL=10[kΩ]
Large Signal Voltage Gain	AV	25℃	60	100	—	dB	RL=10[kΩ]
Input Common-mode Voltage Range	Vicm	25℃	0	-	1.8	V	VSS ~ VDD-1.2[V]
Common-mode Rejection Ratio	CMRR	25℃	45	60	—	dB	—
Power Supply Rejection Ratio	PSRR	25℃	60	80	—	dB	—
Output Source Current (*10)	IOH	25℃	4	7	—	mA	VDD - 0.4[V]
Output Sink Current (*10)	IOL	25℃	9	14	—	mA	VSS + 0.4[V]
Slew Rate	SR	25℃	—	5.0	—	V/μs	CL=25[pF]
Gain Band width	FT	25℃	—	4	—	MHz	CL=25[pF], AV=40[dB]
Phase Margin	θ	25℃	—	50	—	°	CL=25[pF], AV=40[dB]
Total Harmonic Distortion	THD	25℃	—	0.03	—	%	VOUT=0.8[Vp-p], f=1[kHz]

(*8) Absolute value
(*9) Full range BU7495: Ta=-40[℃]~+85[℃] BU7495S: Ta=-40[℃]~+105[℃]
(*10) Under the high temperature environment, consider the power dissipation of IC when selecting the output current.
When the terminal short circuits are continuously output, the output current is reduced to climb to the temperature inside IC

○BU7481 family(Unless otherwise specified VDD=+3[V], VSS=0[V], Ta=25[℃])

Parameter	Symbol	Temperature Range	Limits			Unit	Condition
			BU7481G, BU7481SG				
			Min.	Typ.	Max.		
Input Offset Voltage (*11)	Vio	25℃	—	1	8	mV	—
Input Offset Current (*11)	Iio	25℃	—	1	—	pA	—
Input Bias Current (*11)	Ib	25℃	—	1	—	pA	—
Supply Current (*12)	IDD	25℃	—	420	750	μA	RL=∞ All Op-Amps AV=0[dB],VIN=0.9[V]
		Full range	—	—	900		
High Level Output Voltage	VOH	25℃	VDD-0.1	—	—	V	RL=10[kΩ]
Low Level Output Voltage	VOL	25℃	—	—	VSS+0.1	V	RL=10[kΩ]
Large Signal Voltage Gain	AV	25℃	70	105	—	dB	RL=10[kΩ]
Input Common-mode Voltage Range	Vicm	25℃	0	—	1.8	V	VSS ~ VDD-1.2[V]
Common-mode Rejection Ratio	CMRR	25℃	45	60	—	dB	—
Power Supply Rejection Ratio	PSRR	25℃	60	80	—	dB	—
Output Source Current (*13)	IOH	25℃	5	8	—	mA	VDD - 0.4[V]
Output Sink Current (*13)	IOL	25℃	9	16	—	mA	VSS + 0.4[V]
Slew Rate	SR	25℃	—	3.2	—	V/μs	CL=25[pF]
Gain Band width	FT	25℃	—	2.8	—	MHz	CL=25[pF], AV=40[dB]
Phase Margin	θ	25℃	—	50	—	°	CL=25[pF], AV=40[dB]
Total Harmonic Distortion	THD	25℃	—	0.03	—	%	VOUT=0.8[Vp-p], f=1[kHz]

(*11) Absolute value
(*12) Full range BU7481: Ta=-40[℃]~+85[℃] BU7481S: Ta=-40[℃]~+105[℃]
(*13) Under the high temperature environment, consider the power dissipation of IC when selecting the output current.
When the terminal short circuits are continuously output, the output current is reduced to climb to the temperature inside IC.

○BU7485 family(Unless otherwise specified VDD=+3[V], VSS=0[V], Ta=25[℃])

Parameter	Symbol	Temperature Range	Limits			Unit	Condition
			BU7485G, BU7485SG				
			Min.	Typ.	Max.		
Input Offset Voltage (*14)	Vio	25℃	—	1	9.5	mV	—
Input Offset Current (*14)	Iio	25℃	—	1	—	pA	—
Input Bias Current (*14)	Ib	25℃	—	1	—	pA	—
Supply Current (*15)	IDD	25℃	—	1500	2000	μA	RL=∞ All Op-Amps AV=0[dB],VIN=0.8[V]
		Full range	—	—	2400		
High Level Output Voltage	VOH	25℃	VDD-0.1	—	—	V	RL=10[kΩ]
Low Level Output Voltage	VOL	25℃	—	—	VSS+0.1	V	RL=10[kΩ]
Large Signal Voltage Gain	AV	25℃	70	105	—	dB	RL=10[kΩ]
Input Common-mode Voltage Range	Vicm	25℃	0	—	1.6	V	VSS ~ VDD-1.4[V]
Common-mode Rejection Ratio	CMRR	25℃	45	60	—	dB	—
Power Supply Rejection Ratio	PSRR	25℃	60	80	—	dB	—
Output Source Current (*16)	IOH	25℃	4	8	—	mA	VDD-0.4[V]
Output Sink Current (*16)	IOL	25℃	7	12	—	mA	VSS + 0.4[V]
Slew Rate	SR	25℃	—	10	—	V/μs	CL=25[pF]
Gain Band width	FT	25℃	—	10	—	MHz	CL=25[pF], AV=40[dB]
Phase Margin	θ	25℃	—	50	—	°	CL=25[pF], AV=40[dB]
Total Harmonic Distortion	THD	25℃	—	0.03	—	%	VOUT=0.7[Vp-p], f=1[kHz]

(*14) Absolute value
(*15) Full range BU7485: Ta=-40[℃]~+85[℃] BU7485S: Ta=-40[℃]~+105[℃]
(*16) Under the high temperature environment, consider the power dissipation of IC when selecting the output current.
When the terminal short circuits are continuously output, the output current is reduced to climb to the temperature inside IC.

○BU5281 family(Unless otherwise specified VDD=+3[V], VSS=0[V], Ta=25[℃])

Parameter	Symbol	Temperature Range	Limits			Unit	Condition
			BU5281G, BU5281SG				
			Min.	Typ.	Max.		
Input Offset Voltage (*17)	Vio	25℃	—	0.1	2.5	mV	—
Input Offset Voltage drift (*17)	ΔVio/ΔT	-	—	0.8	—	μV/℃	—
Input Offset Current (*17)	Iio	25℃	—	1	—	pA	—
Input Bias Current (*17)	Ib	25℃	—	1	—	pA	—
Supply Current (*18)	IDD	25℃	—	750	1000	μA	RL=∞ All Op-Amps AV=0[dB],VIN=0.9[V]
		Full range	—	—	1200		
High Level Output Voltage	VOH	25℃	VDD-0.1	—	—	V	RL=10[kΩ]
Low Level Output Voltage	VOL	25℃	—	—	VSS+0.1	V	RL=10[kΩ]
Large Signal Voltage Gain	AV	25℃	70	110	—	dB	RL=10[kΩ]
Input Common-mode Voltage Range	Vicm	25℃	0	—	1.8	V	VSS ~ VDD - 1.2[V]
Common-mode Rejection Ratio	CMRR	25℃	45	60	—	dB	—
Power Supply Rejection Ratio	PSRR	25℃	60	80	—	dB	—
Output Source Current (*19)	IOH	25℃	5	8	—	mA	VDD-0.4[V]
Output Sink Current (*19)	IOL	25℃	10	16	—	mA	VSS+0.4[V]
Slew Rate	SR	25℃	—	2.0	—	V/μs	CL=25[pF]
Gain Band width	FT	25℃	—	3	—	MHz	CL=25[pF], AV=40[dB]
Phase Margin	θ	25℃	—	40	—	°	CL=25[pF], AV=40[dB]
Input Referred Noise Voltage	Vin	25℃	—	18	—	$nV/(Hz)^{1/2}$	AV=40[dB], f=1[kHz]
			—	3.2	—	μVrms	AV=40[dB], DINAUDIO
Total Harmonic Distortion	THD	25℃	—	0.003	—	%	VOUT=0.4[Vp-p], f=1[kHz]

(*17) Absolute value
(*18) Full range BU5281: Ta=-40[℃]~+85[℃] BU5281S: Ta=-40[℃]~+105[℃]
(*19) Under the high temperature environment, consider the power dissipation of IC when selecting the output current.
When the terminal short circuits are continuously output, the output current is reduced to climb to the temperature inside IC.

●Reference Data (BU7291 family)

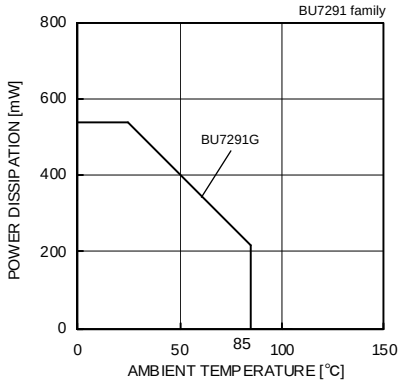


Fig.1
Derating curve

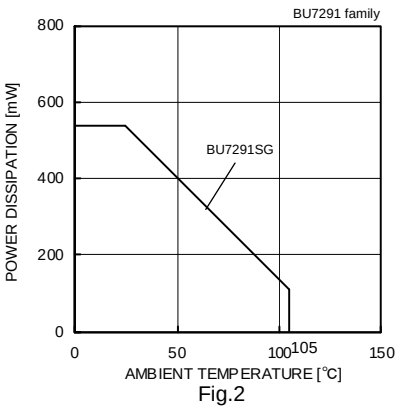


Fig.2
Derating curve

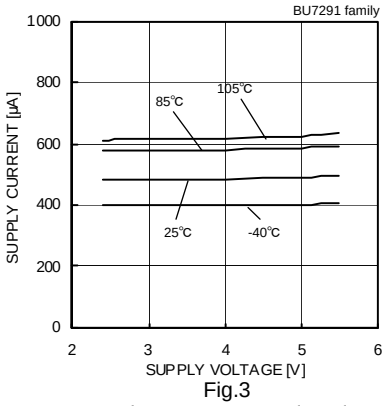


Fig.3
Supply Current – Supply Voltage

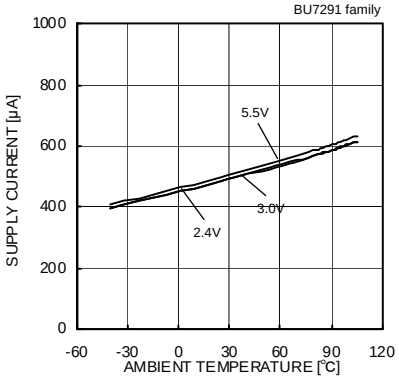


Fig.4
Supply Current
– Ambient Temperature

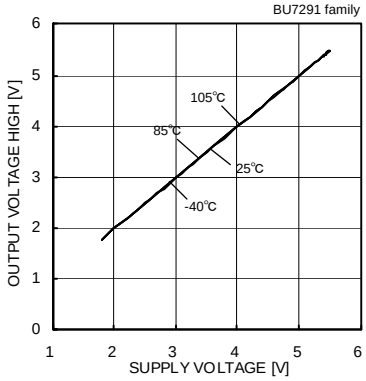


Fig.5
Output Voltage High
– Supply Voltage (RL=10[kΩ])

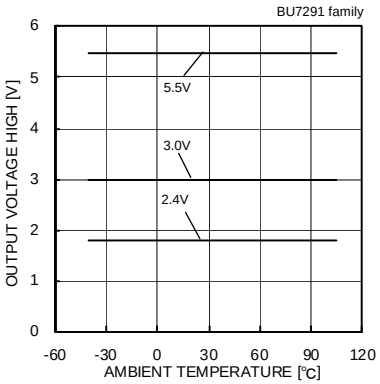


Fig.6
Output Voltage High
– Ambient Temperature (RL=10[kΩ])

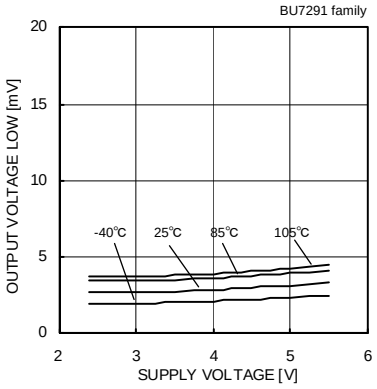


Fig.7
Output Voltage Low
– Supply Voltage (RL=10[kΩ])

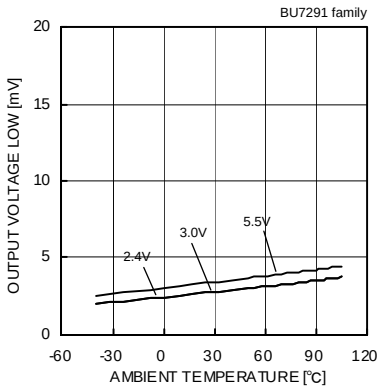


Fig.8
Output Voltage Low
– Ambient Temperature (RL=10[kΩ])

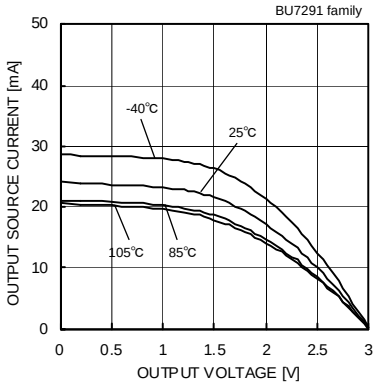


Fig.9
Output Source Current
– Output Voltage (VDD=3[V])

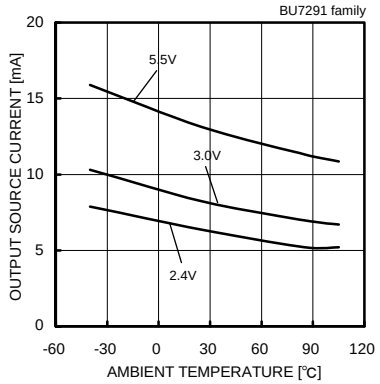


Fig.10
Output Source Current – Ambient Temperature
(VOUT=VDD-0.4[V])

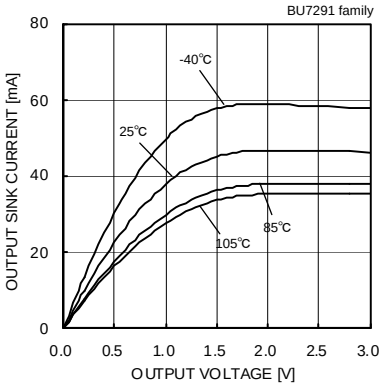


Fig.11
Output Sink Current – Output Voltage
(VDD=3[V])

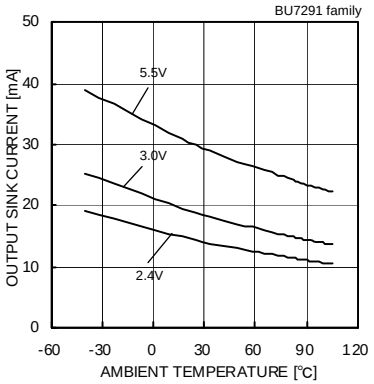


Fig.12
Output Sink Current – Ambient Temperature
(VOUT=VSS+0.4[V])

(*)The above data is ability value of sample, it is not guaranteed.BU7291G: -40[℃] ~ +85[℃] BU7291SG: -40[℃] ~ +105[℃]

●Reference Data (BU7291 family)

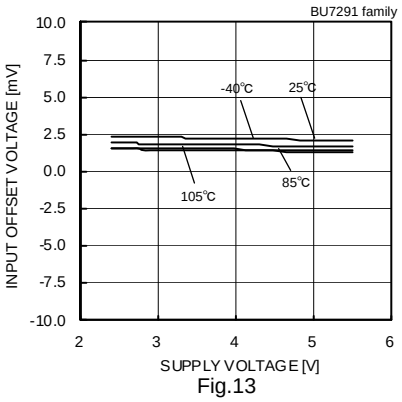


Fig.13
Input Offset Voltage – Supply Voltage
(Vicm=VDD, VOUT=1.5[V])

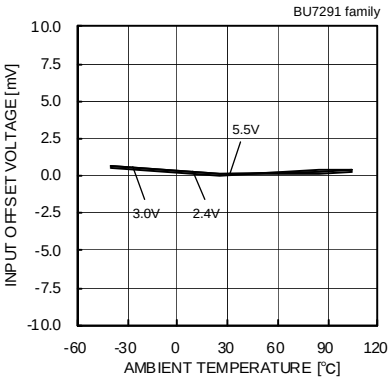


Fig.14
Input Offset Voltage – Ambient Temperature
(Vicm=VDD, VOUT=1.5[V])

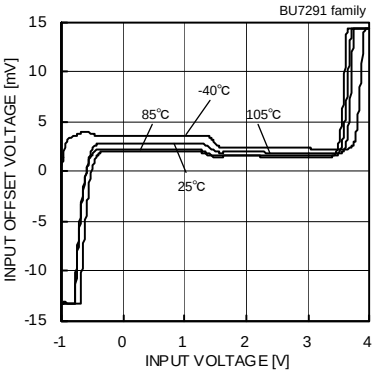


Fig.15
Input Offset Voltage – Input Voltage
(VDD=3[V])

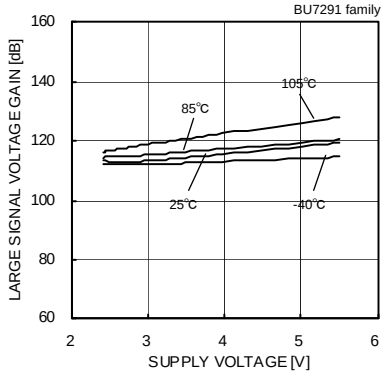


Fig.16
Large Signal Voltage Gain
– Supply Voltage

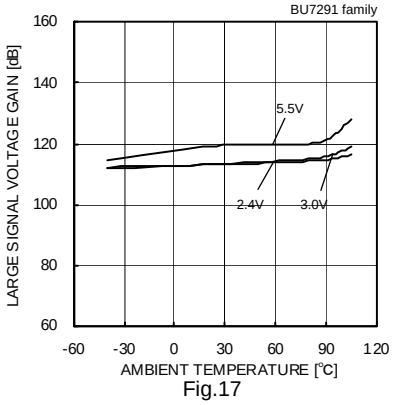


Fig.17
Large Signal Voltage Gain
– Ambient Temperature

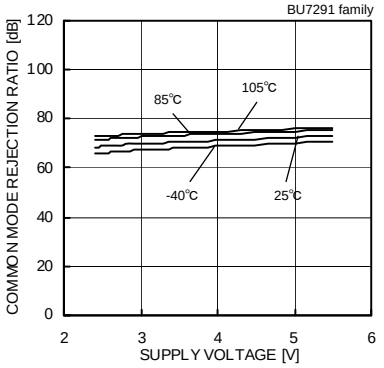


Fig.18
Common Mode Rejection Ratio
– Supply Voltage (VDD=3[V])

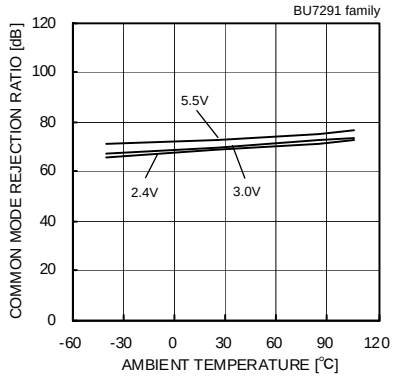


Fig.19
Common Mode Rejection Ratio
– Ambient Temperature

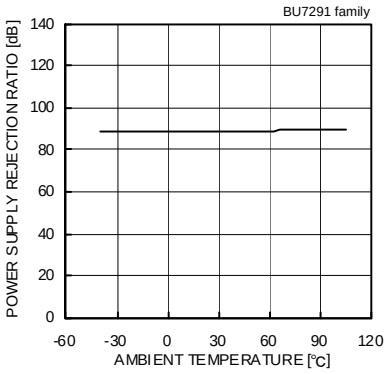


Fig.20
Power Supply Rejection Ratio
– Ambient Temperature

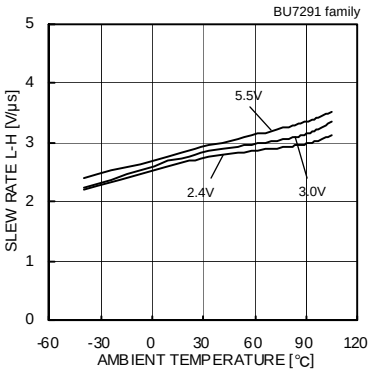


Fig.21
Slew Rate L-H
– Ambient Temperature

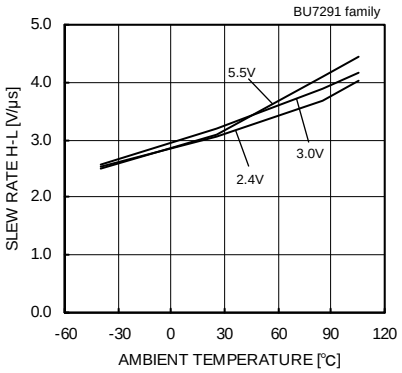


Fig.22
Slew Rate H-L – Ambient Temperature

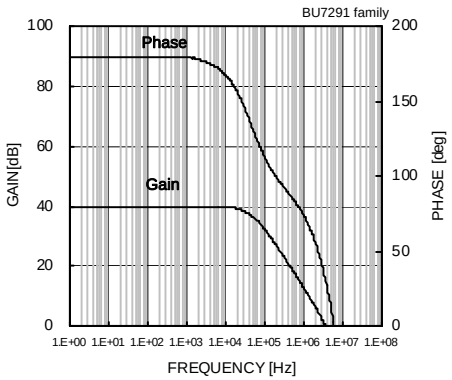


Fig.23
Voltage Gain－Frequency

(*)The above data is ability value of sample, it is not guaranteed. BU7291G: -40[℃] ~ +85[℃] BU7291SG: -40[℃] ~ +105[℃]

●Reference Data (BU7255 family)

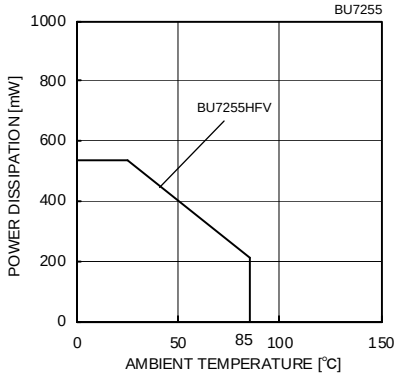


Fig.24
Derating curve

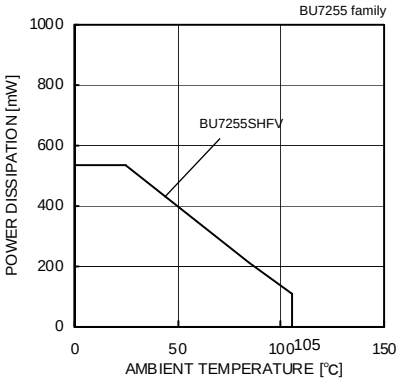


Fig.25
Derating curve

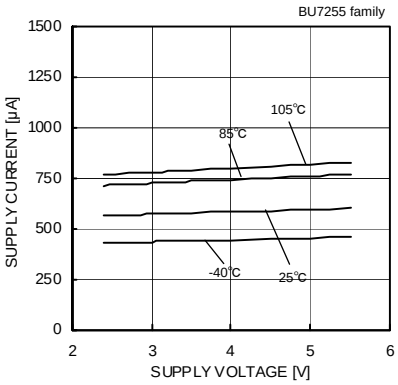


Fig.26
Supply Current – Supply Voltage

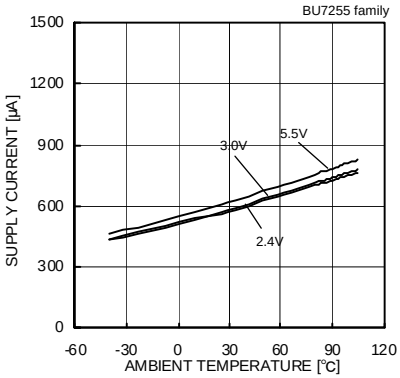


Fig.27
Supply Current
– Ambient Temperature

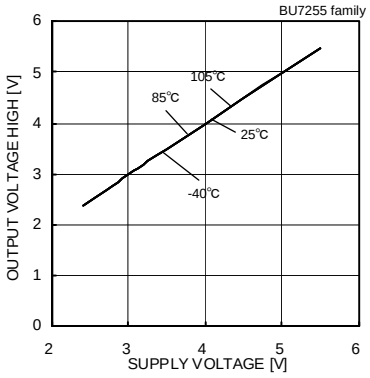


Fig.28
Output Voltage High
– Supply Voltage (RL=10[kΩ])

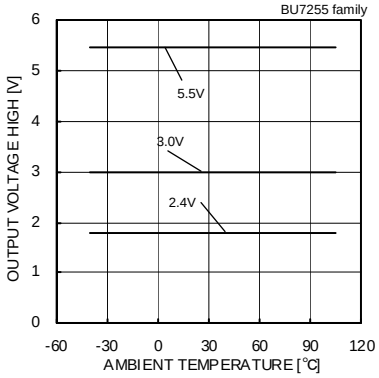


Fig.29
Output Voltage High
– Ambient Temperature (RL=10[kΩ])

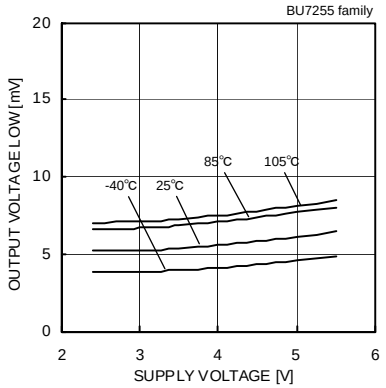


Fig.30
Output Voltage Low
– Supply Voltage (RL=10[kΩ])

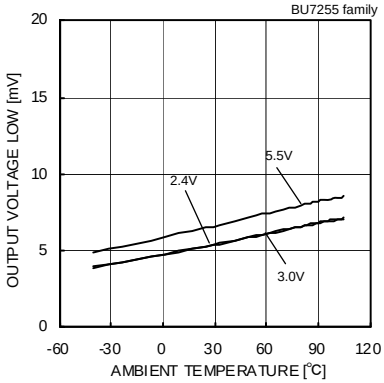


Fig.31
Output Voltage Low
– Ambient Temperature (RL=10[kΩ])

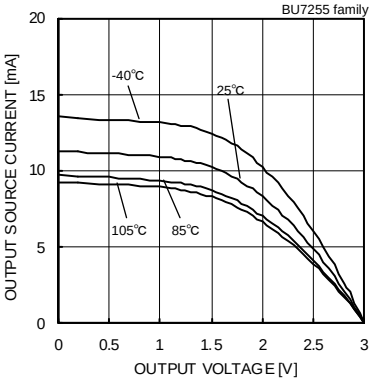


Fig.32
Output Source Current
– Output Voltage (VDD=3[V])

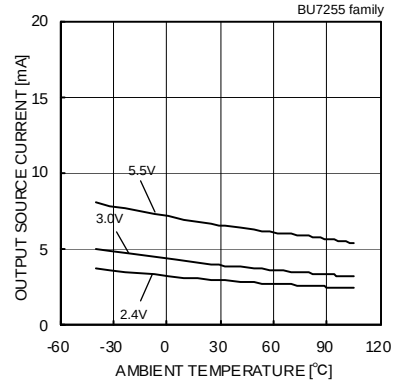


Fig.33
Output Source Current –Ambient Temperature
(VOUT=VDD-0.4[V])

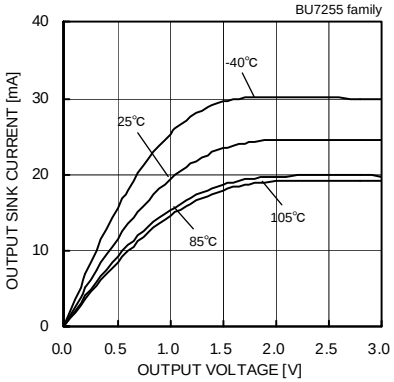


Fig.34
Output Sink Current – Output Voltage
(VDD=3[V])

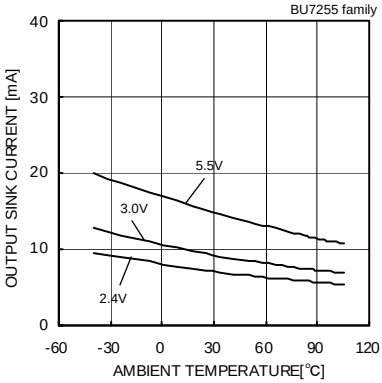


Fig.35
Output Sink Current – Ambient Temperature
(VOUT=VSS+0.4[V])

(*)The above data is ability value of sample, it is not guaranteed. BU7255HFV: -40[℃] ~ +85[℃] BU7255SHFV: -40[℃] ~ +105[℃]

●Reference Data (BU7255 family)

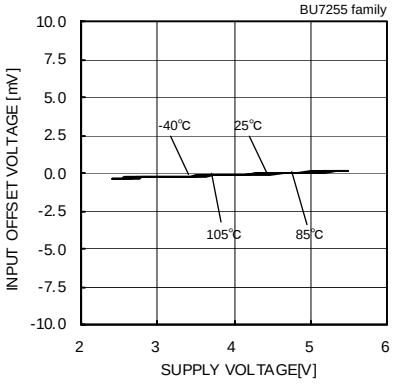


Fig.36
Input Offset Voltage – Supply Voltage
(Vicm=VDD, VOUT=1.5V])

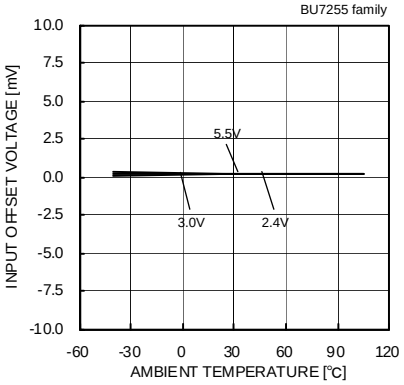


Fig.37
Input Offset Voltage – Ambient Temperature
(Vicm=VDD, VOUT=1.5[V])

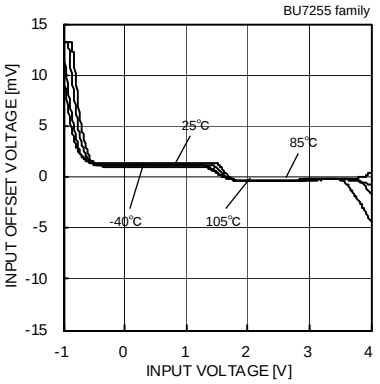


Fig.38
Input Offset Voltage – Input Voltage
(VDD=3[V])

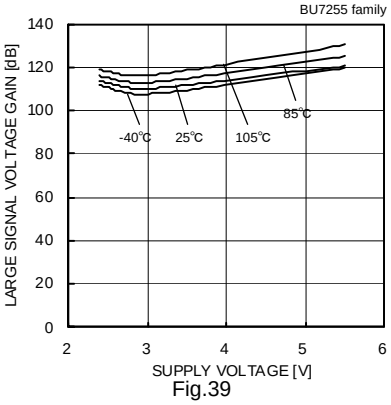


Fig.39
Large Signal Voltage Gain
– Supply Voltage

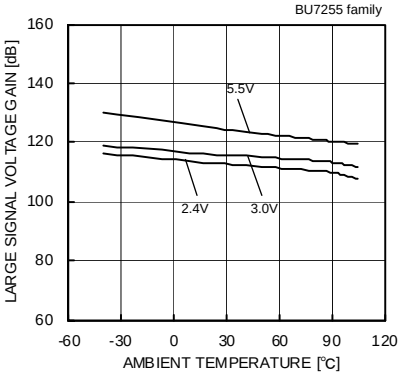


Fig.40
Large Signal Voltage Gain
– Ambient Temperature

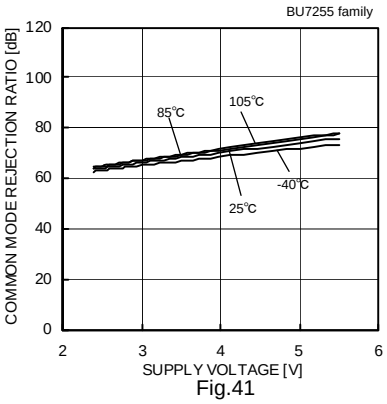


Fig.41
Common Mode Rejection Ratio
– Supply Voltage (VDD=3[V])

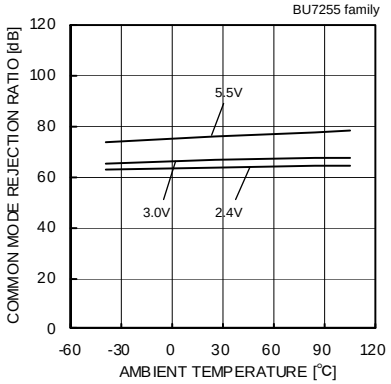


Fig.42
Common Mode Rejection Ratio
– Ambient Temperature

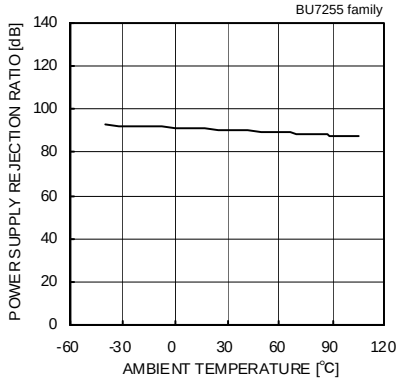


Fig.43
Power Supply Rejection Ratio
– Ambient Temperature

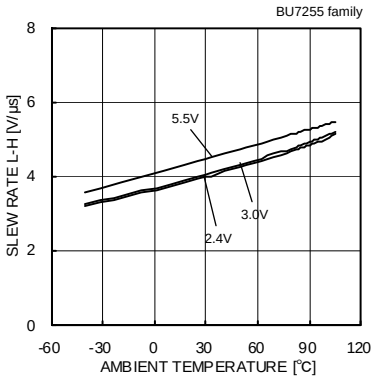


Fig.44
Slew Rate L-H
– Ambient Temperature

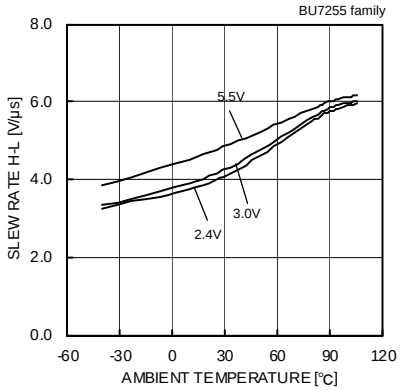


Fig.45
Slew Rate H-L – Ambient Temperature

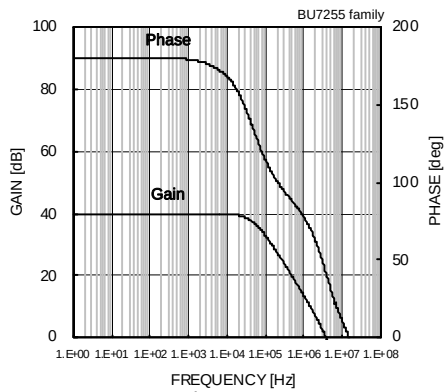


Fig.46
Voltage Gain－Frequency

(*)The above data is ability value of sample, it is not guaranteed. BU7255HFV: -40[℃] ~ +85[℃] BU7255SHFV: -40[℃] ~ +105[℃]

●Reference Data (BU7495 family)

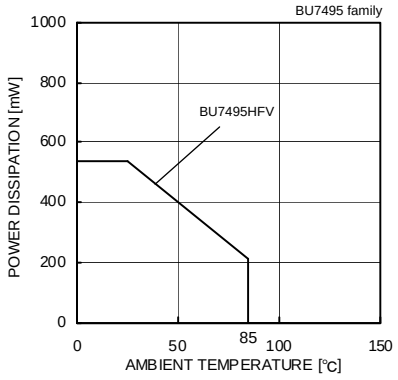


Fig.47
Derating curve

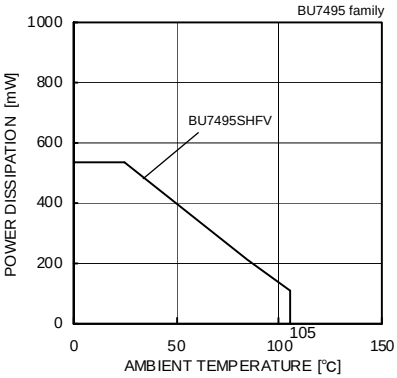


Fig.48
Derating curve

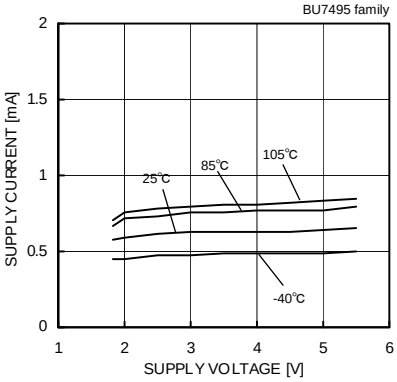


Fig.49
Supply Current – Supply Voltage

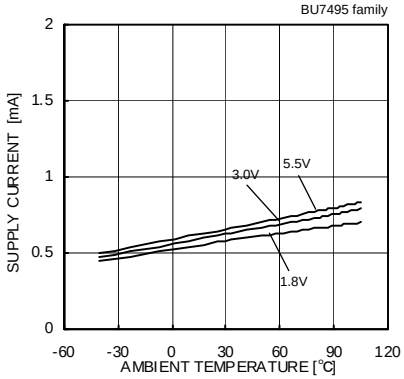


Fig.50
Supply Current
– Ambient Temperature

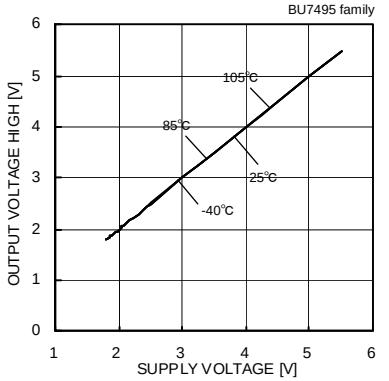


Fig.51
Output Voltage High
– Supply Voltage (RL=10[kΩ])

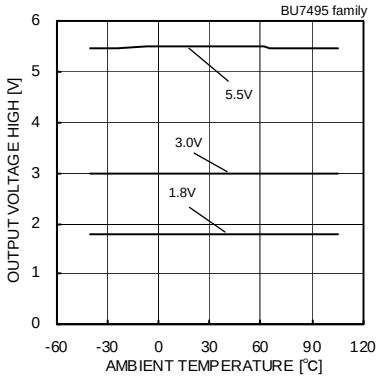


Fig.52
Output Voltage High
– Ambient Temperature (RL=10[kΩ])

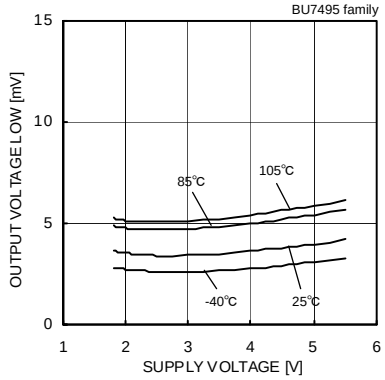


Fig.53
Output Voltage Low
– Supply Voltage (RL=10[kΩ])

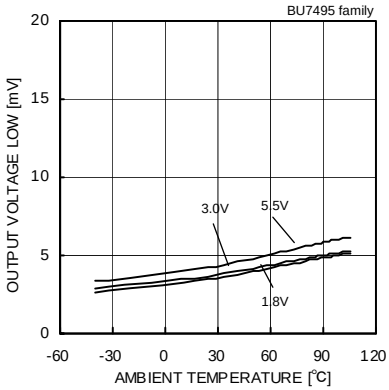


Fig.54
Output Voltage Low – Ambient
Temperature (RL=10[kΩ])

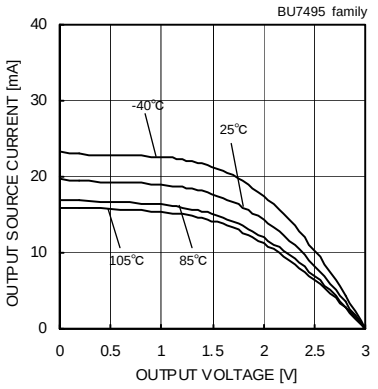


Fig.55
Output Source Current – Output
Voltage (VDD=3[V])

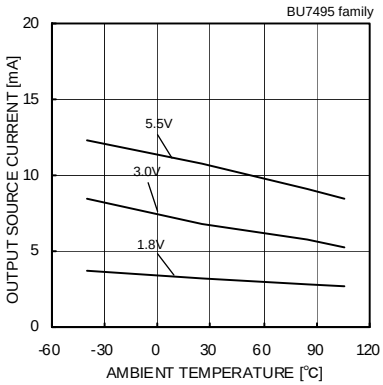


Fig.56
Output Source Current – Ambient Temperature
(VOUT=VDD-0.4[V])

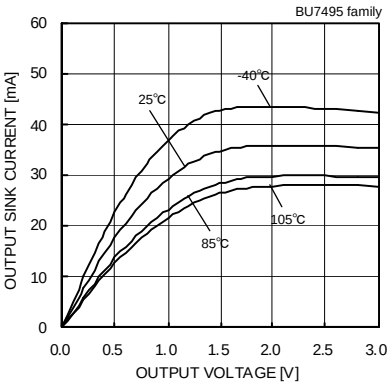


Fig.57
Output Sink Current – Output Voltage
(VDD=3[V])

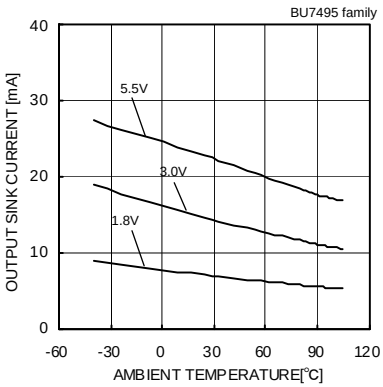


Fig.58
Output Sink Current – Ambient Temperature
(VOUT=VSS+0.4[V])

(*)The above data is ability value of sample, it is not guaranteed. BU7495HFV: -40[℃] ~ +85[℃] BU7495SHFV: -40[℃] ~ +105[℃]

●Reference Data (BU7495 family)

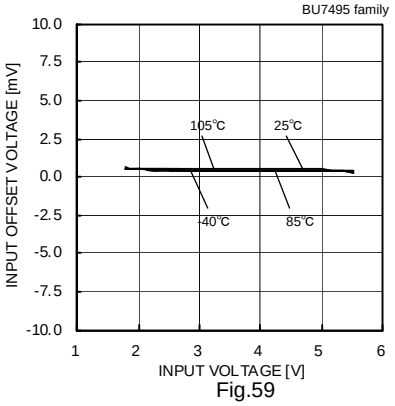


Fig.59
Input Offset Voltage – Supply Voltage
(Vicm=VDD-1.2[V], VOUT=1.5[V])

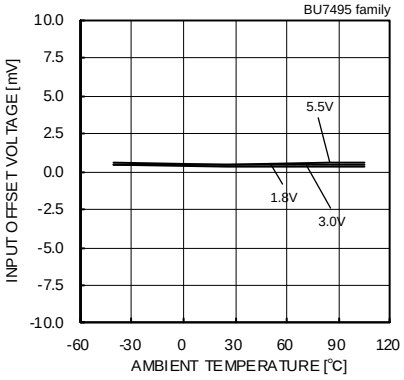


Fig.60
Input Offset Voltage – Ambient Temperature
(Vicm=VDD, VOUT=1.5[V])

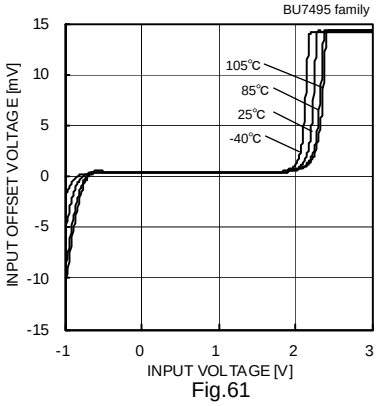


Fig.61
Input Offset Voltage – Input Voltage
(VDD=3[V])

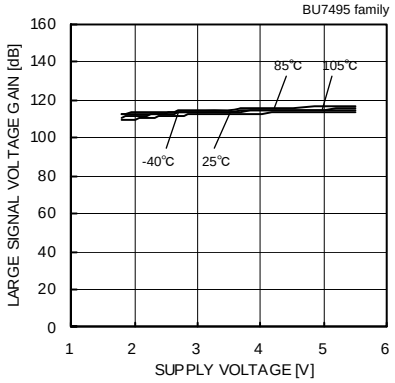


Fig.62
Large Signal Voltage Gain
– Supply Voltage

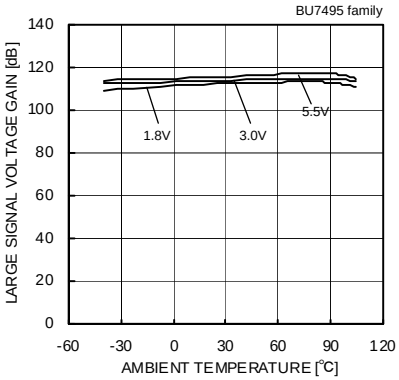


Fig.63
Large Signal Voltage Gain
– Ambient Temperature

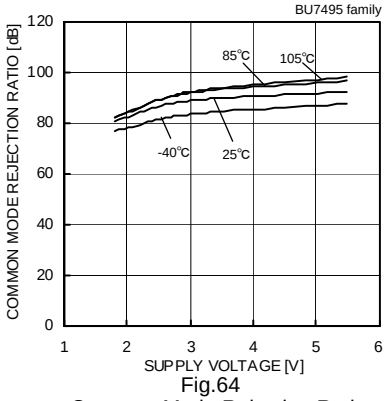


Fig.64
Common Mode Rejection Ratio
– Supply Voltage (VDD=3[V])

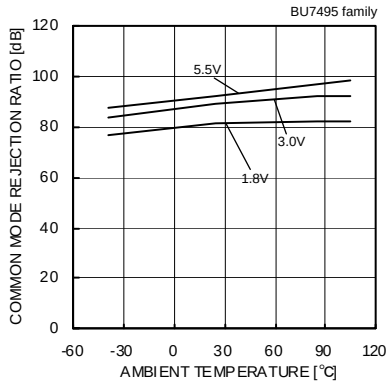


Fig.65
Common Mode Rejection Ratio
– Ambient Temperature

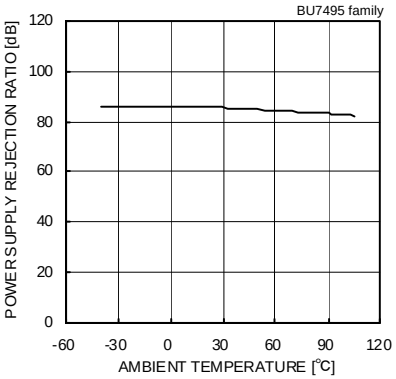


Fig.66
Power Supply Rejection Ratio
– Ambient Temperature

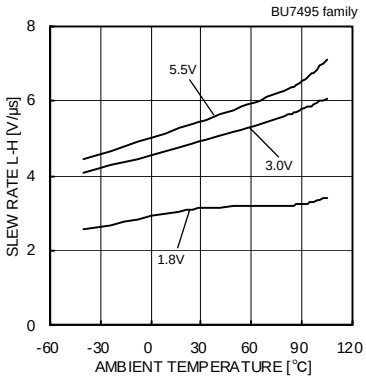


Fig.67
Slew Rate L-H
– Ambient Temperature

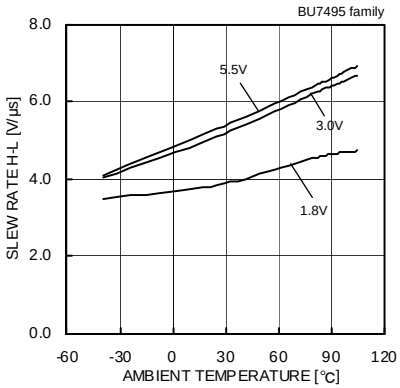


Fig.68
Slew Rate H-L – Ambient Temperature

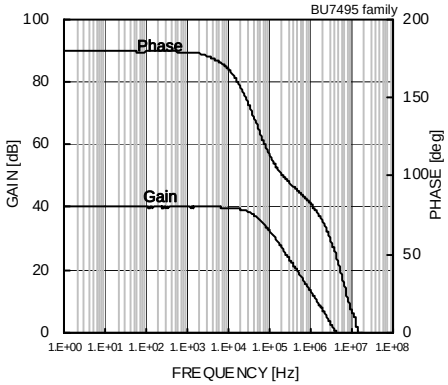


Fig.69
Voltage Gain－Frequency

(*)The above data is ability value of sample, it is not guaranteed. BU7495HFV: -40[℃] ~ +85[℃] BU7495SHFV: -40[℃] ~ +105[℃]

●Reference Data (BU7481 family)

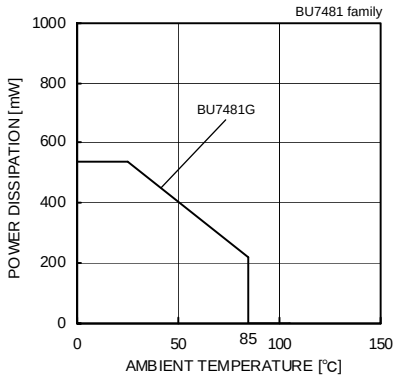


Fig.70
Derating curve

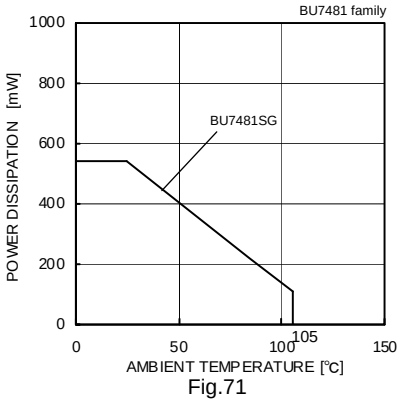


Fig.71
Derating curve

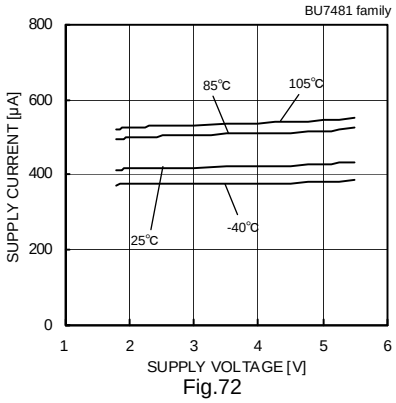


Fig.72
Supply Current – Supply Voltage

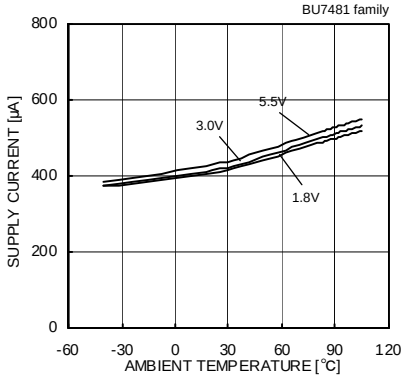


Fig.73
Supply Current
– Ambient Temperature

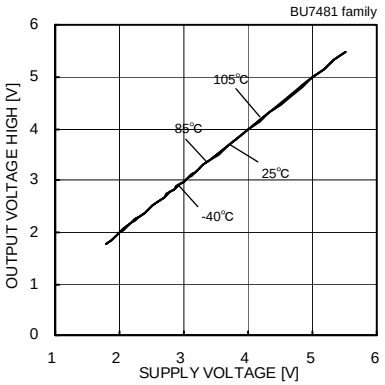


Fig.74
Output Voltage High
– Supply Voltage (RL=10[kΩ])

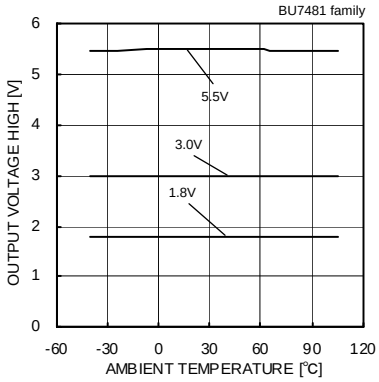


Fig.75
Output Voltage High
– Ambient Temperature (RL=10[kΩ])

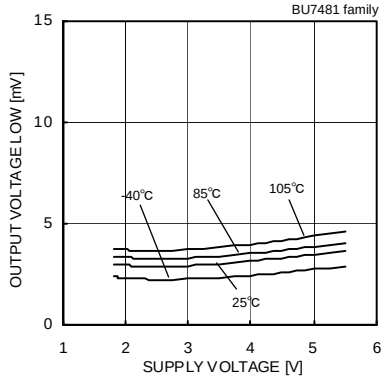


Fig.76
Output Voltage Low
– Supply Voltage (RL=10[kΩ])

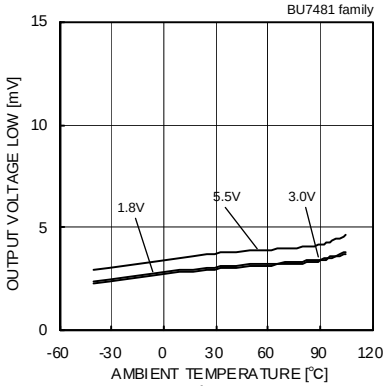


Fig.77
Output Voltage Low – Ambient Temperature (RL=10[kΩ])

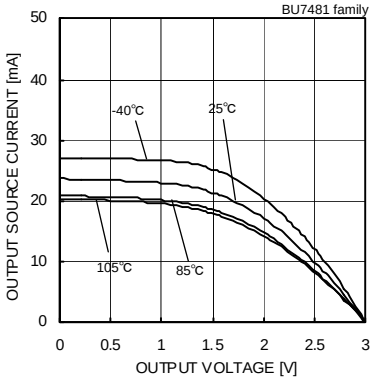


Fig.78
Output Source Current – Output Voltage (VDD=3[V])

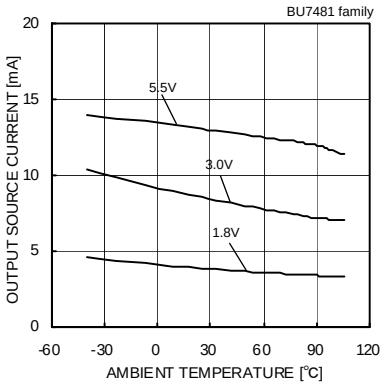


Fig.79
Output Source Current –Ambient Temperature
(VOUT=VDD-0.4[V])

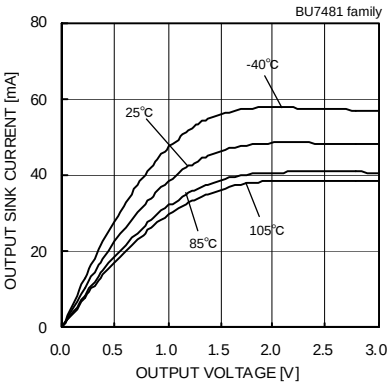


Fig.80
Output Sink Current – Output Voltage
(VDD=3[V])

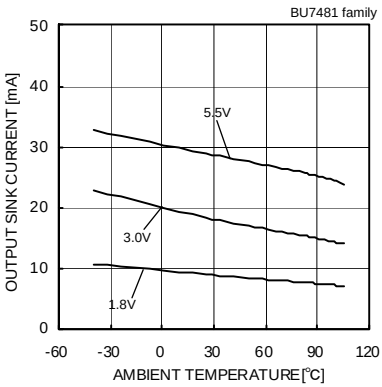


Fig.81
Output Sink Current – Ambient Temperature
(VOUT=VSS+0.4[V])

(*)The above data is ability value of sample, it is not guaranteed. BU7481G: -40[℃] ~ +85[℃] BU7481SG: -40[℃] ~ +105[℃]

●Reference Data (BU7481 family)

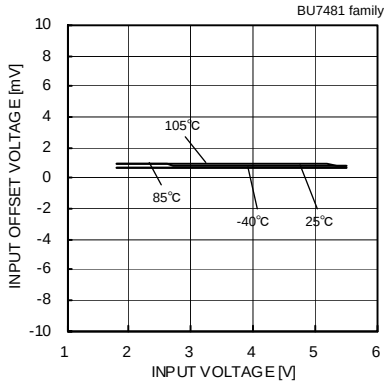


Fig.82
Input Offset Voltage – Supply Voltage
(Vicm=VDD-1.2[V], VOUT=1.5[V])

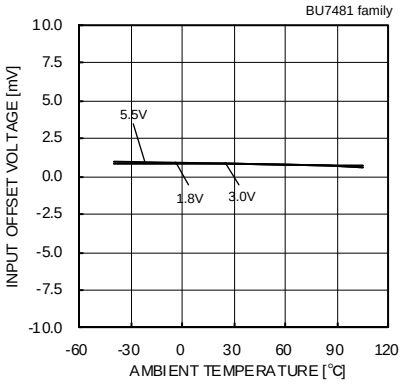


Fig.83
Input Offset Voltage – Ambient Temperature
(Vicm=VDD-1.2[V], VOUT=1.5[V])

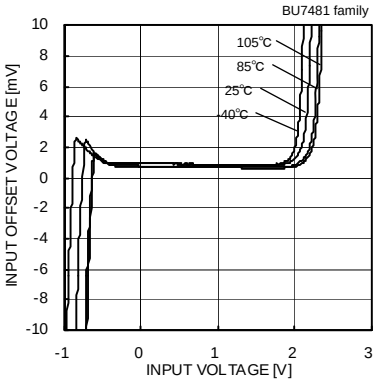


Fig.84
Input Offset Voltage – Input Voltage
(VDD=3[V])

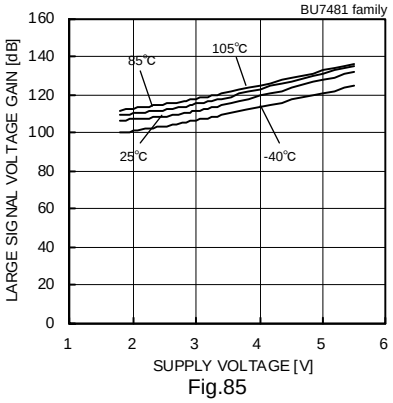


Fig.85
Large Signal Voltage Gain
– Supply Voltage

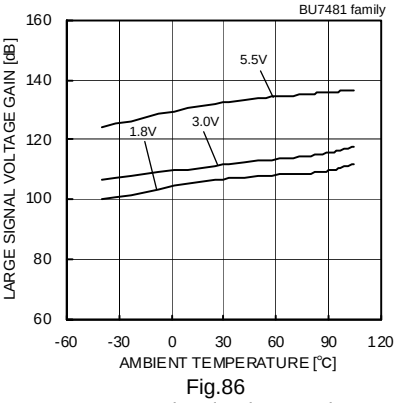


Fig.86
Large Signal Voltage Gain
– Ambient Temperature

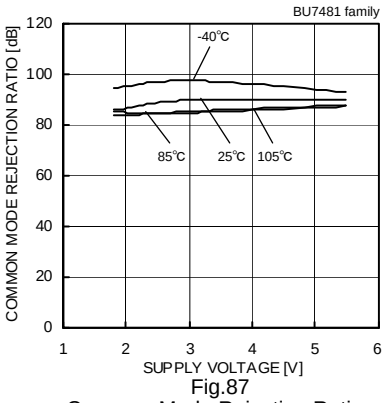


Fig.87
Common Mode Rejection Ratio
– Supply Voltage (VDD=3[V])

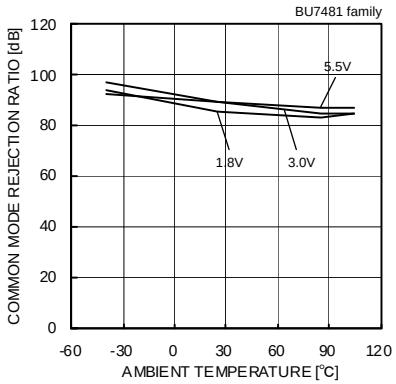


Fig.88
Common Mode Rejection Ratio
– Ambient Temperature

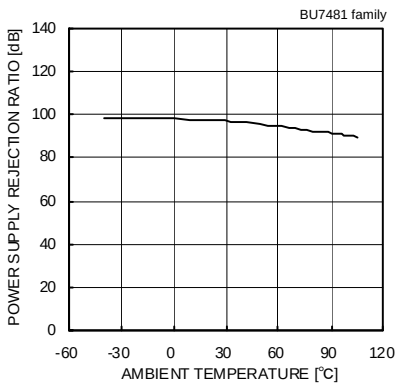


Fig.89
Power Supply Rejection Ratio
– Ambient Temperature

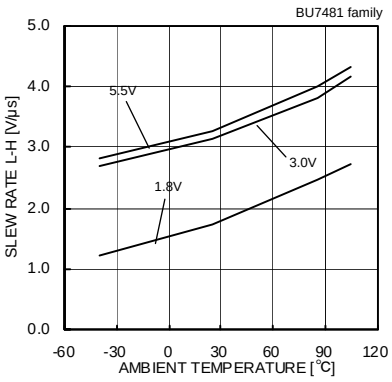


Fig.90
Slew Rate L-H
– Ambient Temperature

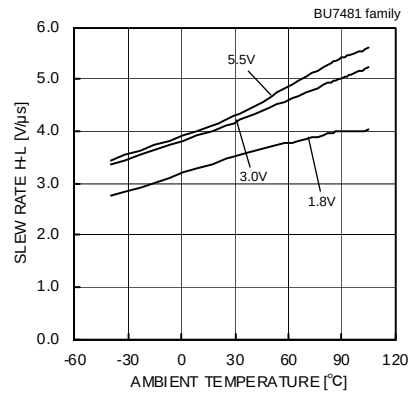


Fig.91
Slew Rate H-L – Ambient Temperature

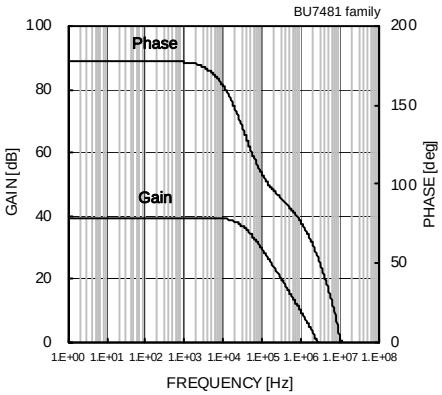


Fig.92
Voltage Gain－Frequency

(*)The above data is ability value of sample, it is not guaranteed. BU7481G: -40[℃] ~ +85[℃] BU7481SG: -40[℃] ~ +105[℃]

●Reference Data (BU7485 family)

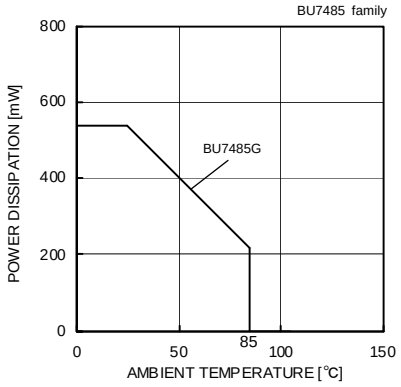


Fig.93
Derating curve

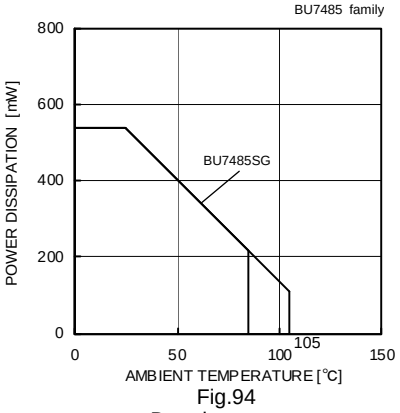


Fig.94
Derating curve

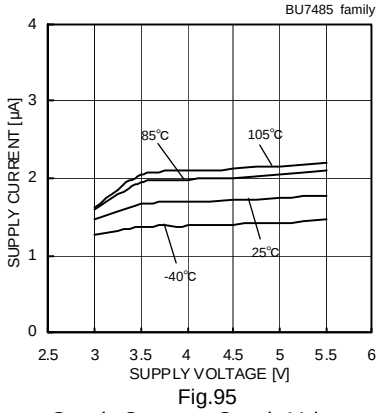


Fig.95
Supply Current – Supply Voltage

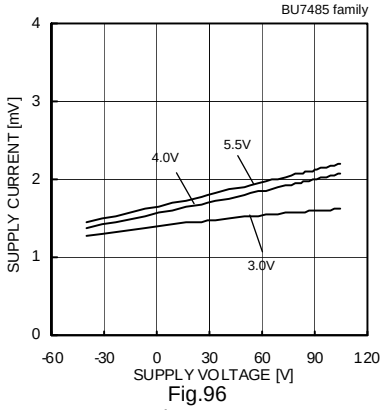


Fig.96
Supply Current
– Ambient Temperature

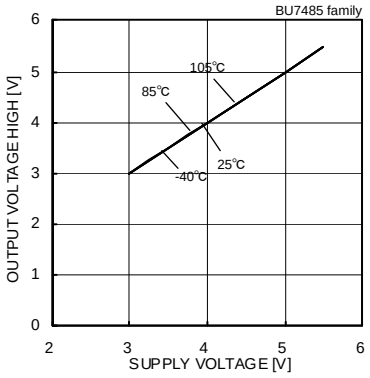


Fig.97
Output Voltage High
– Supply Voltage (RL=10[kΩ])

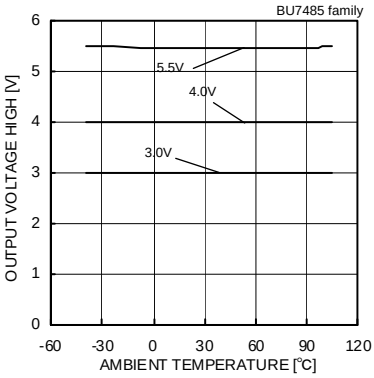


Fig.98
Output Voltage High
– Ambient Temperature (RL=10[kΩ])

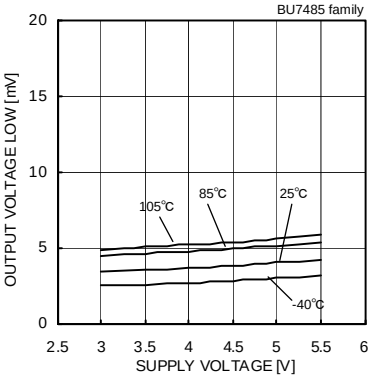


Fig.99
Output Voltage Low
– Supply Voltage (RL=10[kΩ])

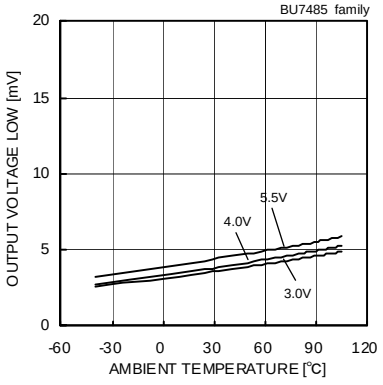


Fig.100
Output Voltage Low
– Ambient Temperature (RL=10[kΩ])

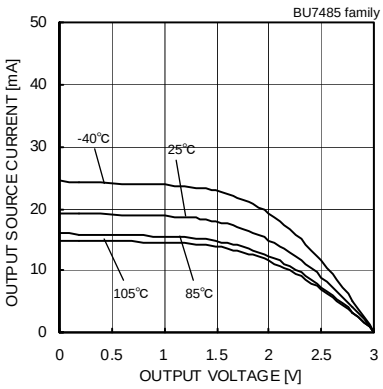


Fig.101
Output Source Current
– Output Voltage (VDD=3[V])

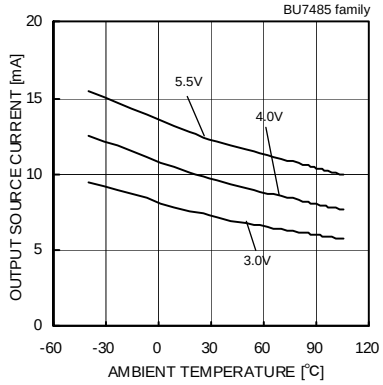


Fig.102
Output Source Current –Ambient Temperature
(VOUT=VDD-0.4[V])

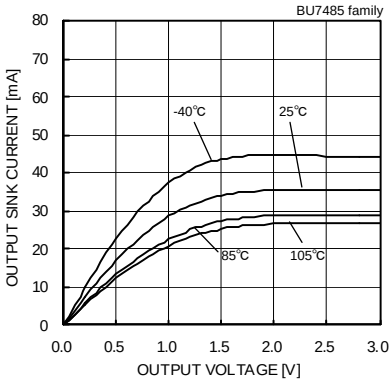


Fig.103
Output Sink Current – Output Voltage
(VDD=3[V])

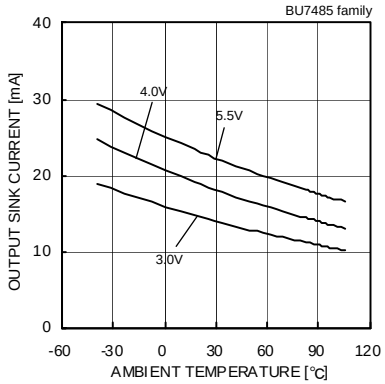


Fig.104
Output Sink Current – Ambient Temperature
(VOUT=VSS+0.4[V])

(*)The above data is ability value of sample, it is not guaranteed. BU7485G: -40[℃] ~ +85[℃] BU7485SG: -40[℃] ~ +105[℃]

●Reference Data (BU7485 family)

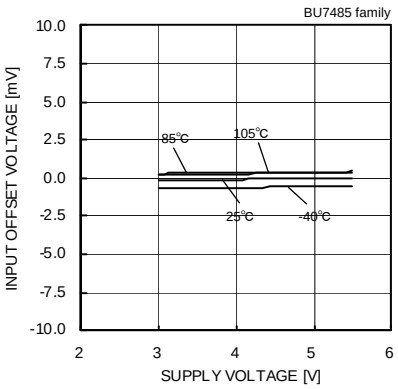


Fig.105
Input Offset Voltage – Supply Voltage
(Vicm=VDD-1.4[V], VOUT=1.5[V])

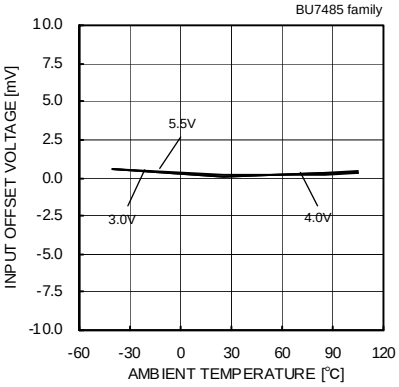


Fig.106
Input Offset Voltage – Ambient Temperature
(Vicm=VDD-1.4[V], VOUT=1.5[V])

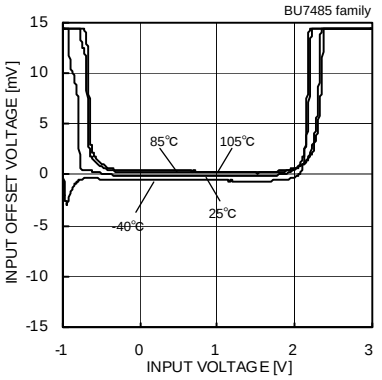


Fig.107
Input Offset Voltage – Input Voltage
(VDD=3[V])

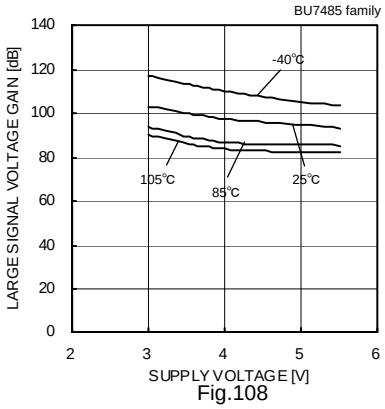


Fig.108
Large Signal Voltage Gain
– Supply Voltage

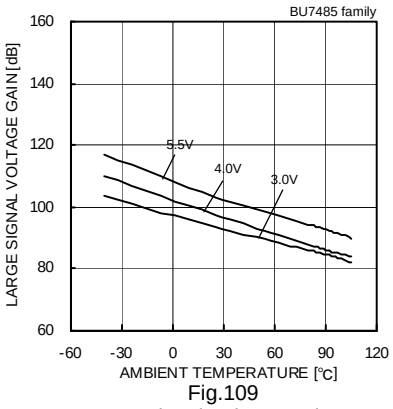


Fig.109
Large Signal Voltage Gain
– Ambient Temperature

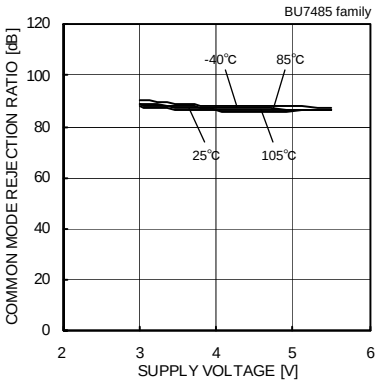


Fig.110
Common Mode Rejection Ratio
– Supply Voltage (VDD=3[V])

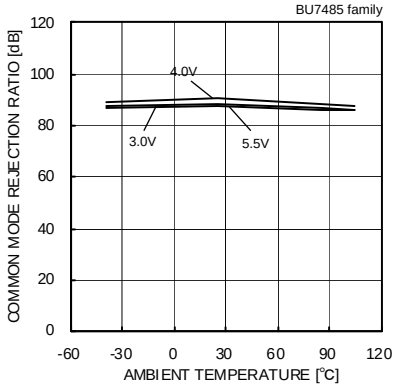


Fig.111
Common Mode Rejection Ratio
– Ambient Temperature

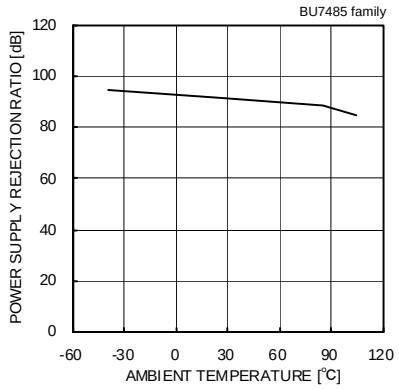


Fig.112
Power Supply Rejection Ratio
– Ambient Temperature

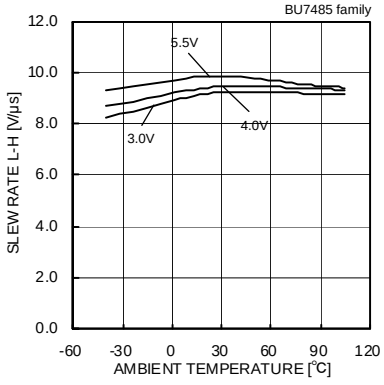


Fig.113
Slew Rate L-H
– Ambient Temperature

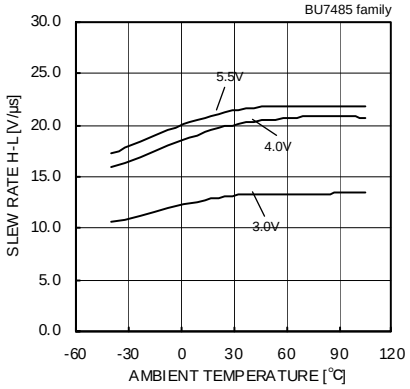


Fig.114
Slew Rate H-L – Ambient Temperature

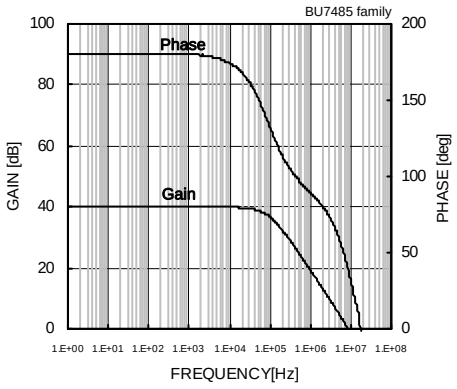


Fig.115
Voltage Gain－Frequency

(*)The above data is ability value of sample, it is not guaranteed. BU7485G: -40[℃] ~ +85[℃] BU7485SG: -40[℃] ~ +105[℃]

●Reference Data (BU5281 family)

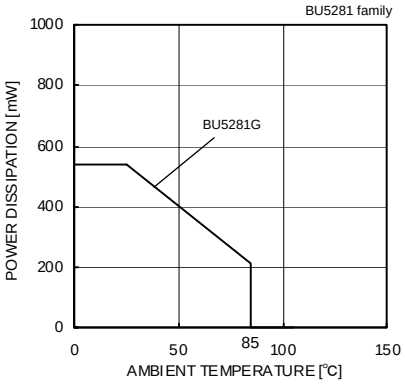


Fig.116
Derating curve

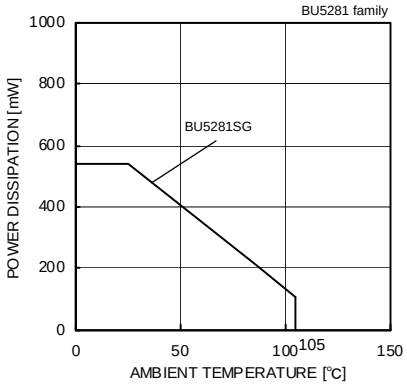


Fig.117
Derating curve

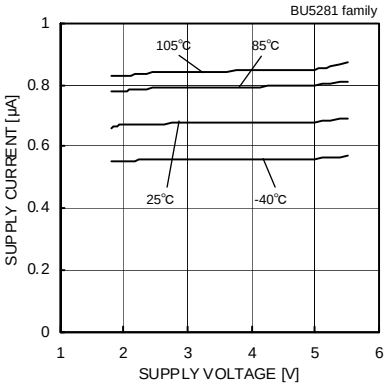


Fig.118
Supply Current – Supply Voltage

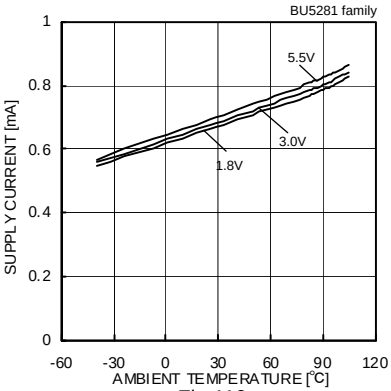


Fig.119
Supply Current
– Ambient Temperature

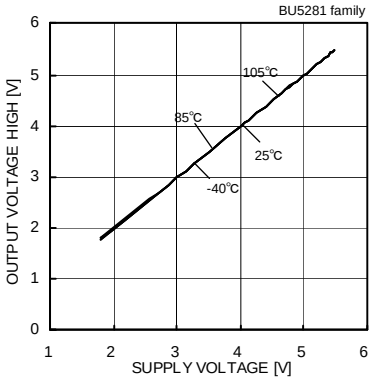


Fig.120
Output Voltage High
– Supply Voltage (RL=10[kΩ])

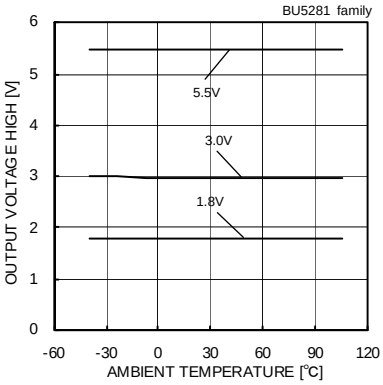


Fig.121
Output Voltage High
– Ambient Temperature (RL=10[kΩ])

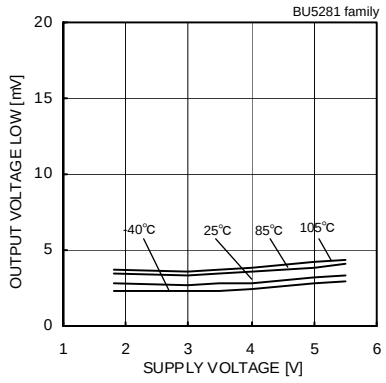


Fig.122
Output Voltage Low
– Supply Voltage (RL=10[kΩ])

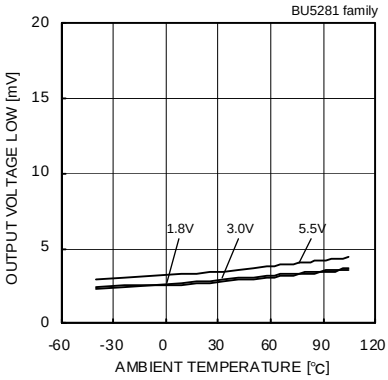


Fig.123
Output Voltage Low
– Ambient Temperature (RL=10[kΩ])

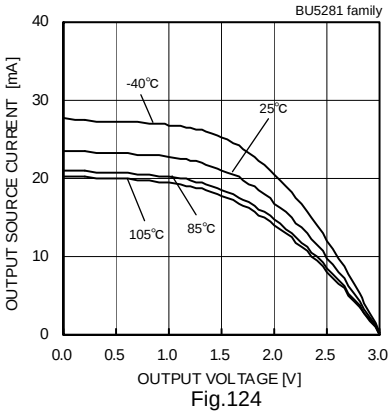


Fig.124
Output Source Current
– Output Voltage (VDD=3[V])

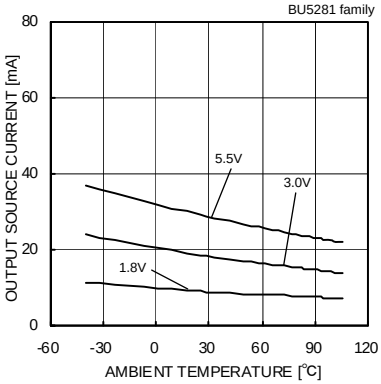


Fig.125
Output Source Current –Ambient Temperature
(VOUT=VDD-0.4[V])

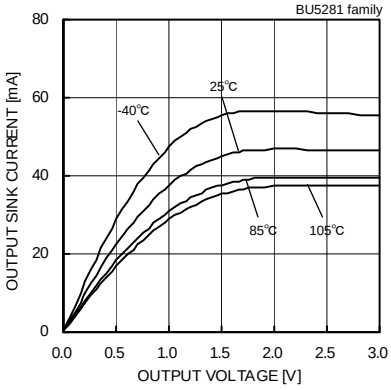


Fig.126
Output Sink Current – Output Voltage
(VDD=3[V])

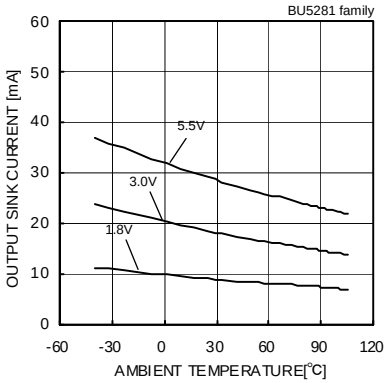


Fig.127
Output Sink Current – Ambient Temperature
(VOUT=VSS+0.4[V])

(*)The above data is ability value of sample, it is not guaranteed. BU5281G: -40[℃] ~ +85[℃] BU5281SG: -40[℃] ~ +105[℃]

●Reference Data (BU5281 family)

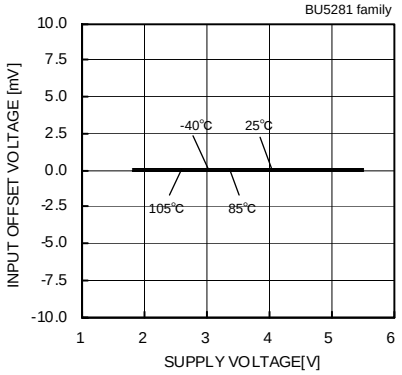


Fig.128
Input Offset Voltage – Supply Voltage
(Vicm=VDD-1.2[V], VOUT=1.5[V])

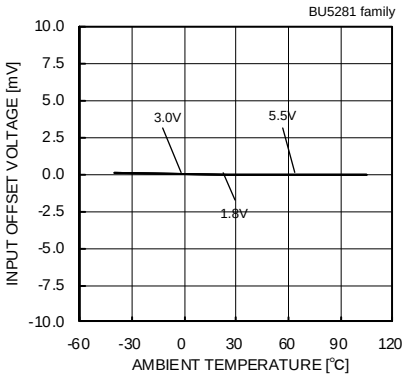


Fig.129
Input Offset Voltage – Ambient Temperature
(Vicm=VDD-1.2[V], VOUT=1.5[V])

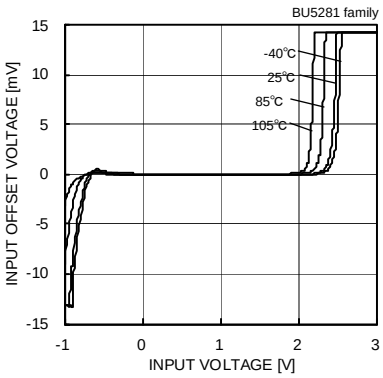


Fig.130
Input Offset Voltage – Input Voltage
(VDD=3[V])

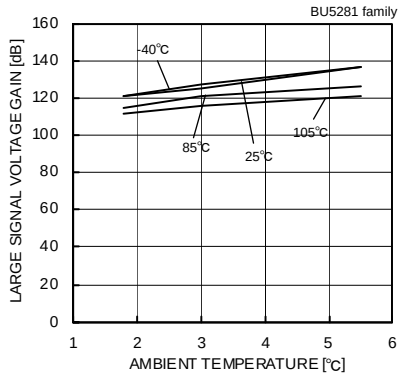


Fig.131
Large Signal Voltage Gain
– Supply Voltage

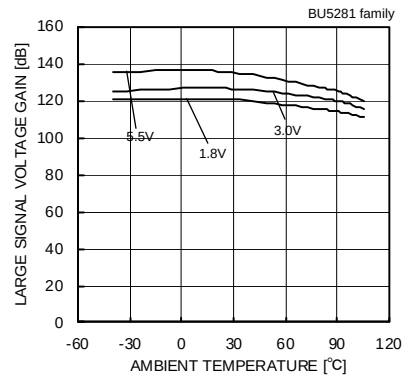


Fig.132
Large Signal Voltage Gain
– Ambient Temperature

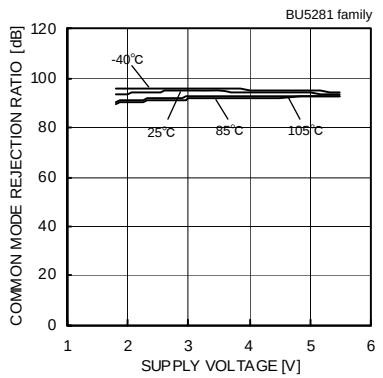


Fig.133
Common Mode Rejection Ratio
– Supply Voltage (VDD=3[V])

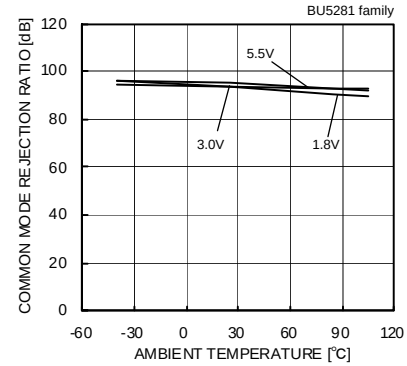


Fig.134
Common Mode Rejection Ratio
– Ambient Temperature

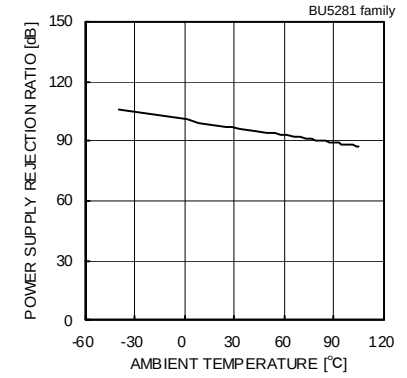


Fig.135
Power Supply Rejection Ratio
– Ambient Temperature

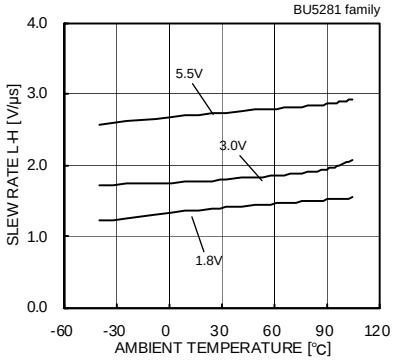


Fig.136
Slew Rate L-H –
Ambient Temperature

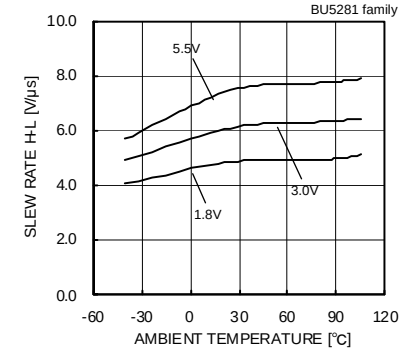


Fig.137
Slew Rate H-L – Ambient Temperature

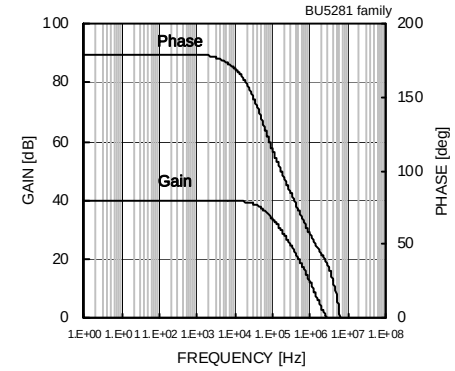


Fig.138
Voltage Gain－Frequency

(*)The above data is ability value of sample, it is not guaranteed. BU5281G: -40[℃] ~ +85[℃] BU5281SG: -40[℃] ~ +105[℃]

●Test circuit 1 NULL method

○Input-Output Full Swing BU7291/BU7255 family

VDD, VSS, EK, Vicm Unit:[V]

Parameter	VF	S1	S2	S3	VDD	VSS	EK	Vicm	Calculation
Input Offset Voltage	VF1	ON	ON	OFF	3	0	-1.5	3	1
Large Signal Voltage Gain	VF2	ON	ON	ON	3	0	-0.5	1.5	2
	VF3						-2.5		
Common-mode Rejection Ratio (Input Common-mode Voltage Range)	VF4	ON	ON	OFF	3	0	-1.5	0	3
	VF5							3	
Power Supply Rejection Ratio	VF6	ON	ON	OFF	2.4	0	-1.2	0	4
	VF7				5.5				

○Ground Sense BU7495/BU7481/BU7485/BU5281 family

VDD, VSS, EK, Vicm Unit:[V]

Parameter		VF	S1	S2	S3	VDD	VSS	EK	Vicm	Calculation
Input Offset Voltage		VF1	ON	ON	OFF	3	0	-1.5	1.8	1
Large Signal Voltage Gain		VF2	ON	ON	ON	3	0	-0.5	0.9	2
		VF3						-2.5		
Common-mode Rejection Ratio (Input Common-mode Voltage Range)		VF4	ON	ON	OFF	3	0	-1.5	0	3
		VF5							1.8	
Power Supply Rejection Ratio	BU7495/BU7481/BU5281	VF6	ON	ON	OFF	1.8	0	-0.9	0	4
	BU7485					3.0				
		VF7				5.5				

－Calculation－

1. Input Offset Voltage (Vio)

$$Vio = \frac{|VF1|}{1+Rf/Rs} \quad [V]$$

2. Large Signal Voltage Gain (Av)

$$Av = 20Log\frac{2\times(1+Rf/Rs)}{|VF2-VF3|} \quad [dB]$$

3 Common-mode Rejection Ratio (CMRR)

$$CMRR = 20Log\frac{\Delta Vicm\times(1+Rf/Rs)}{|VF4-VF5|} \quad [dB]$$

4. Power Supply Rejection Ratio (PSRR)

$$PSRR = 20Log\frac{\Delta V_{DD}\times(1+Rf/Rs)}{|VF6-VF7|} \quad [dB]$$

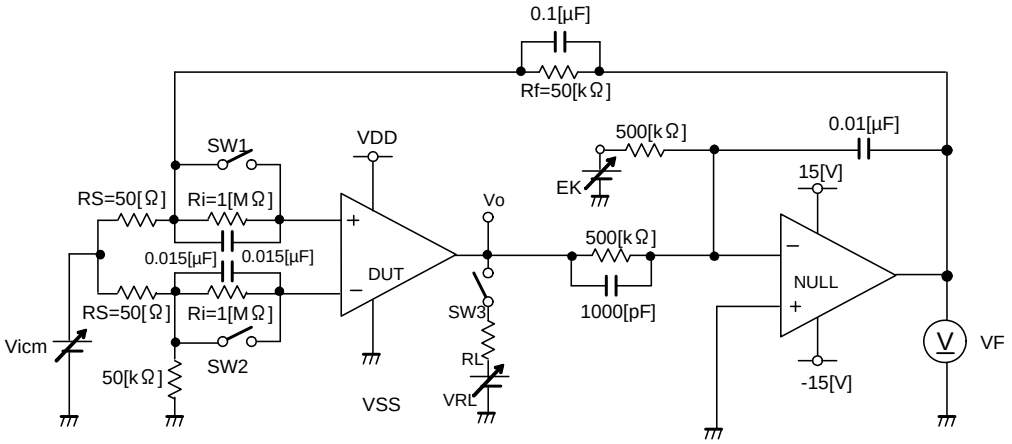


Fig.139 Test circuit 1 (one channel only)

●Test circuit 2 switch condition

SW No.	SW 1	SW 2	SW 3	SW 4	SW 5	SW 6	SW 7	SW 8	SW 9	SW 10	SW 11	SW 12
Supply Current	OFF	OFF	ON	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF
Maximum Output Voltage (RL=10[kΩ])	OFF	ON	OFF	OFF	ON	OFF	OFF	ON	OFF	OFF	ON	OFF
Output Current	OFF	ON	OFF	OFF	ON	OFF	OFF	OFF	OFF	ON	OFF	OFF
Slew Rate	OFF	OFF	ON	OFF	OFF	OFF	ON	OFF	ON	OFF	OFF	ON
Maximum Frequency	ON	OFF	OFF	ON	ON	OFF	OFF	OFF	ON	OFF	OFF	ON

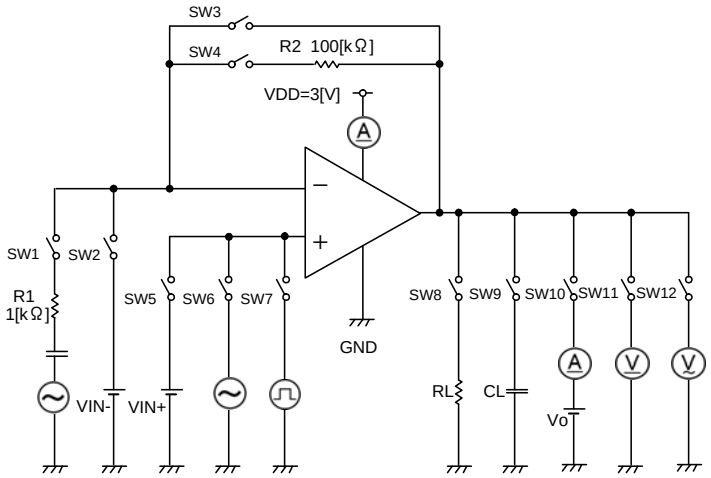


Fig.140 Test circuit 2

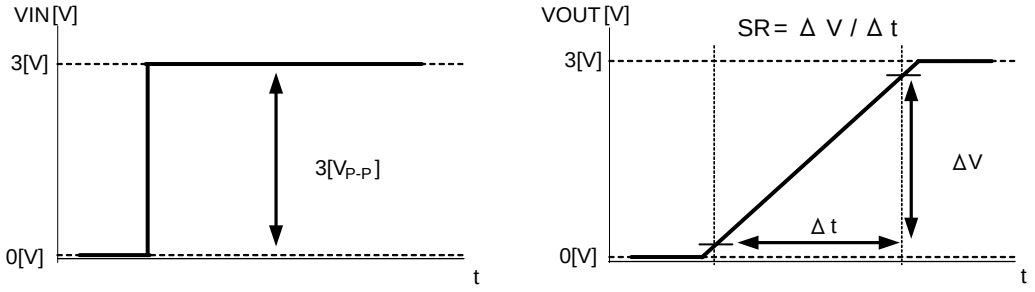


Fig.141 Slew rate input output wave
(Input-Output Full Swing BU7291/BU7255 family)

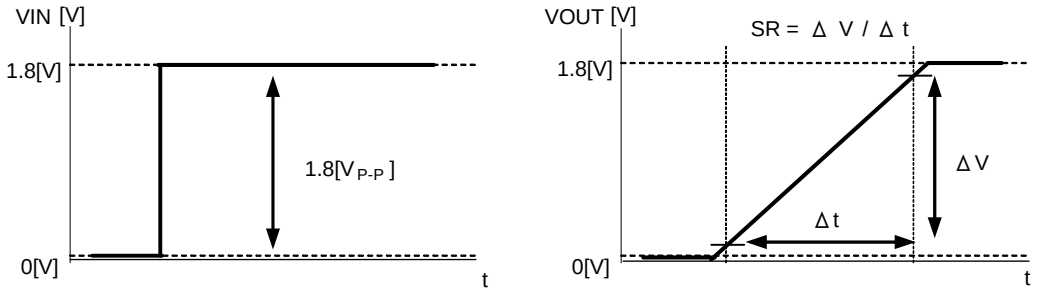


Fig.142 Slew rate input output wave
(Ground Sense BU7495/BU7481/BU7485/BU5281 family)

●Test circuit 3 Channel Separation

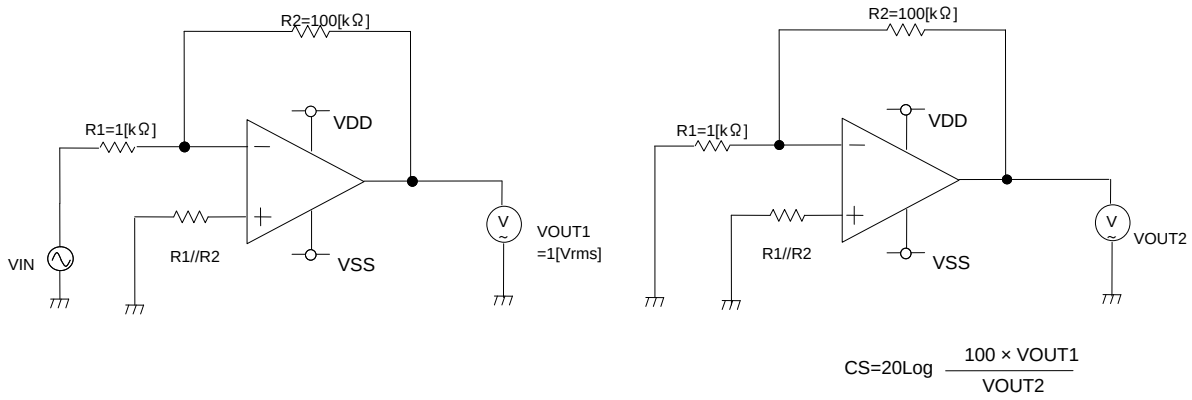


Fig.143 Test circuit 3

●Schematic Diagram

○Input-Output Full Swing BU7291/BU7255 family

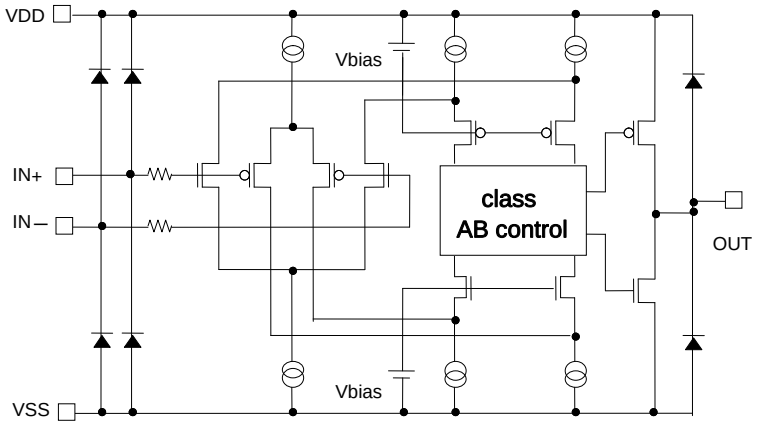


Fig.144 Input-Output Full Swing Schematic Diagram

○Ground Sense BU7495/BU7481/BU7485/BU5281 family

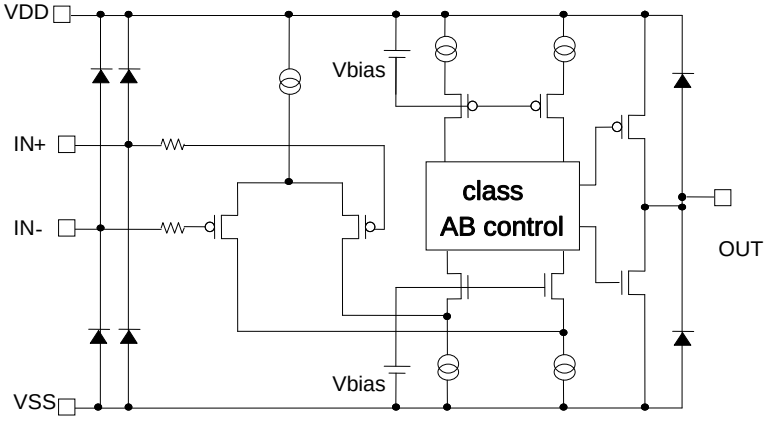


Fig.145 Ground Sense Schematic Diagram

●Examples of circuit

○Voltage follower

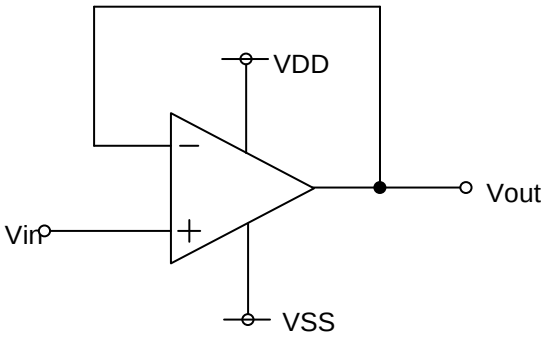


Fig.146 Voltage follower

Voltage gain is 0 [dB].
This circuit controls output voltage (Vout) equal input voltage (Vin), and keeps Vout with stable because of high input impedance and low output impedance.
Vout is shown next formula.
Vout=Vin

○Inverting amplifier

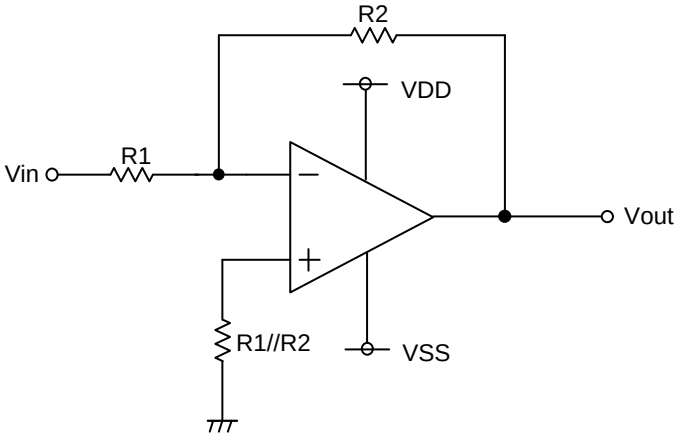


Fig.147 Inverting amplifier circuit

For inverting amplifier, Vin is amplified by voltage gain decided R1 and R2, and phase reversed voltage is outputted. Vout is shown next formula.
Vout=-(R2/R1)・Vin
Input impedance is R1.

○Non-inverting amplifier

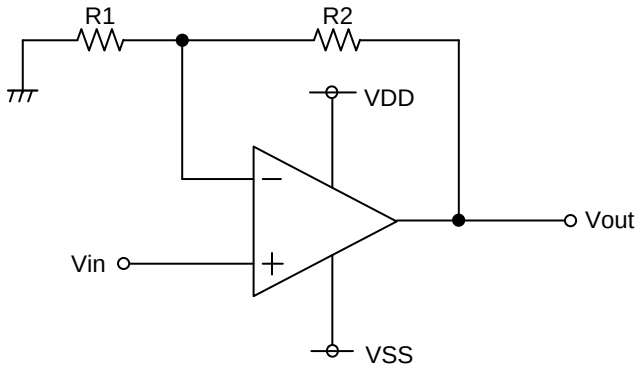


Fig.148 Non-inverting amplifier circuit

For non-inverting amplifier, Vin is amplified by voltage gain decided R1 and R2, and phase is same with Vin.
Vout is shown next formula.
Vout=(1+R2/R1)・Vin
This circuit realizes high input impedance because Input impedance is operational amplifier's input Impedance.

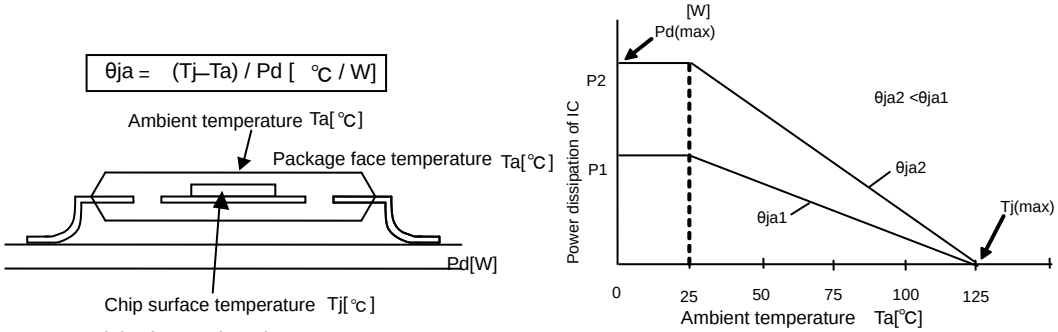
●Derating Curve

Power dissipation (total loss) indicates the power that can be consumed by IC at Ta=25℃(normal temperature).IC is heated when it consumed power, and the temperature of IC ship becomes higher than ambient temperature. The temperature that can be accepted by IC chip depends on circuit configuration, manufacturing process, and consumable power is limited. Power dissipation is determined by the temperature allowed in IC chip (maximum junction temperature) and thermal resistance of package (heat dissipation capability). The maximum junction temperature is typically equal to the maximum value in the storage package (heat dissipation capability). The maximum junction temperature is typically equal to the maximum value in the storage temperature range. Heat generated by consumed power of IC radiates from the mold resin or lead frame of the package. The parameter which indicates this heat dissipation capability (hardness of heat release) is called thermal resistance, represented by the symbol θj-a[℃/W]. The temperature of IC inside the package can be estimated by this thermal resistance.

Fig.149 (a) shows the model of thermal resistance of the package. Thermal resistance θja, ambient temperature Ta, junction temperature Tj, and power dissipation Pd can be calculated by the equation below:

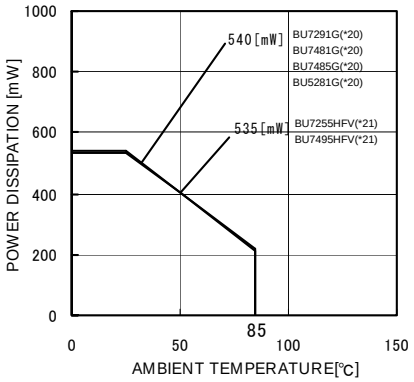
$$\theta ja = (Tj - Ta) / Pd \quad [℃/W] \qquad \cdots\cdots (I)$$

Derating curve in Fig.149 (b) indicates power that can be consumed by IC with reference to ambient temperature. Power that can be consumed by IC begins to attenuate at certain ambient temperature. This gradient is determined by thermal resistance θja. Thermal resistance θja depends on chip size, power consumption, package, ambient temperature, package condition, wind velocity, etc even when the same of package is used. Thermal reduction curve indicates a reference value measured at a specified condition. Fig.150(c)-(d) show a derating curve for an example of BU7291 family, BU7255 family, , BU7495 family , BU7481 family , BU7485 family , BU5281 family.

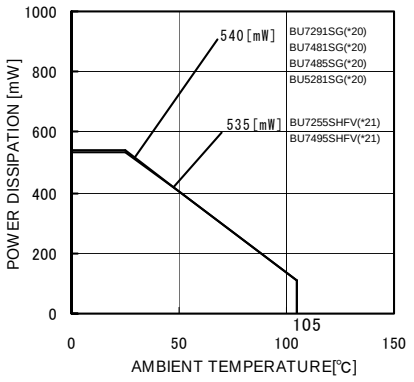


(a) Thermal resistance (b) Derating curve

Fig.149 Thermal resistance and derating



(c) BU7291G BU7481G BU7485G
BU5281G BU7255HFV BU7495HFV



(d) BU7291SG BU7481SG BU7485SG
BU5281SG BU7255SHFV BU7495SHFV

(*20)	(*21)	Unit
5.4	5.35	[mW/℃]

When using the unit above Ta=25[℃], subtract the value above per degree[℃]. Permissible dissipation is the value when FR4 glass epoxy board 70[mm]×70[mm]×1.6[mm] (cooper foil area below 3[%]) is mounted

Fig.150 Derating Curve

●Notes for Use

1) Absolute maximum ratings
Absolute maximum ratings are the values which indicate the limits, within which the given voltage range can be safely charged to the terminal. However, it does not guarantee the circuit operation.

2) Applied voltage to the input terminal
For normal circuit operation of voltage comparator, please input voltage for its input terminal within input common mode voltage VDD + 0.3[V]. Then, regardless of power supply voltage, VSS-0.3[V] can be applied to input terminals without deterioration or destruction of its characteristics.

3) Operating power supply (split power supply/single power supply)
The operational amplifier operates if a given level of voltage is applied between VDD and VSS. Therefore, the operational amplifier can be operated under single power supply or split power supply.

4) Power dissipation (Pd)
If the IC is used under excessive power dissipation. An increase in the chip temperature will cause deterioration of the radical characteristics of IC. For example, reduction of current capability. Take consideration of the effective power dissipation and thermal design with a sufficient margin. Pd is reference to the provided power dissipation curve.

5) Output short circuit
If short circuit occurs between the output terminal and VDD terminal, excessive in output current may flow and generate heat, causing destruction of the IC. Take due care.

6) Using under strong electromagnetic field
Be careful when using the IC under strong electromagnetic field because it may malfunction.

7) Usage of IC
When stress is applied to the IC through warp of the printed circuit board, The characteristics may fluctuate due to the piezo effect. Be careful of the warp of the printed circuit board.

8) Testing IC on the set board
When testing IC on the set board, in cases where the capacitor is connected to the low impedance, make sure to discharge per fabrication because there is a possibility that IC may be damaged by stress. When removing IC from the set board, it is essential to cut supply voltage. As a countermeasure against the static electricity, observe proper grounding during fabrication process and take due care when carrying and storage it.

9) The IC destruction caused by capacitive load
The transistors in circuits may be damaged when VDD terminal and VSS terminal is shorted with the charged output terminal capacitor.When IC is used as a operational amplifier or as an application circuit, where oscillation is not activated by an output capacitor,the output capacitor must be kept below 0.1[μF] in order to prevent the damage mentioned above.

10) Decupling capacitor
Insert the decupling capacitance between VDD and VSS, for stable operation of operational amplifier.

11) Latch up
Be careful of input voltage that exceed the VDD and VSS. When CMOS device have sometimes occur latch up operation. And protect the IC from abnormaly noise.

●Ordering Part Number

B	U	7	4	9	5	S	H	F	V	-	T	R

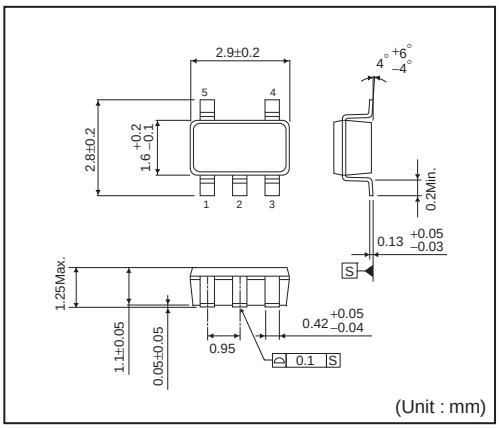
Part No.

Part No.
Input-Output Full Swing
7291 , 7291S , 7255 , 7255S
Ground Sense
7495 , 7495S , 7481 , 7481S
7485 , 7485S , 5281 , 5281S

Package
G: SSOP5
HFV: HVSOF5

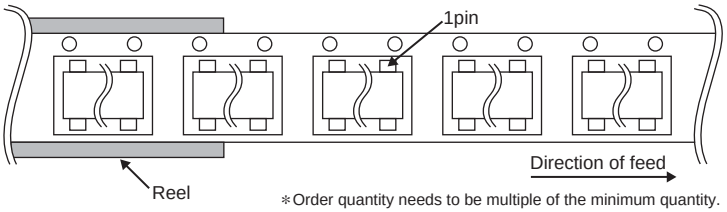
Packaging and forming specification
TR: Embossed tape and reel

SSOP5



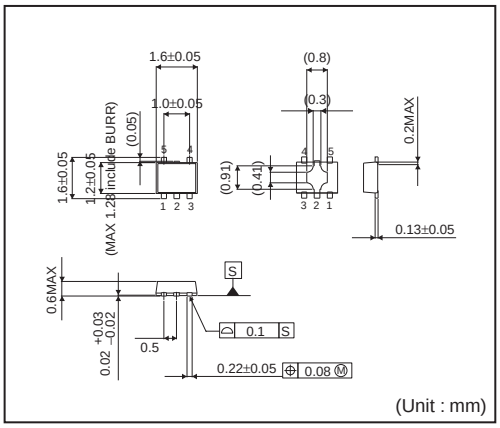
<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	TR (The direction is the 1pin of product is at the upper right when you hold reel on the left hand and you pull out the tape on the right hand)



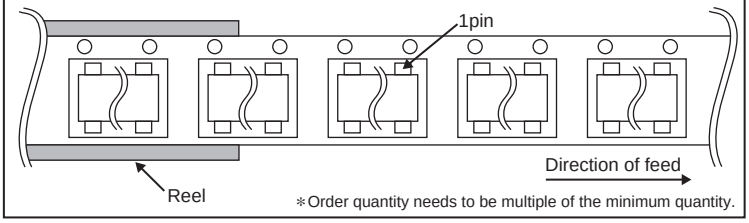
∗Order quantity needs to be multiple of the minimum quantity.

HVSOF5



<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	TR (The direction is the 1pin of product is at the upper right when you hold reel on the left hand and you pull out the tape on the right hand)



∗Order quantity needs to be multiple of the minimum quantity.

Notes

No copying or reproduction of this document, in part or in whole, is permitted without the consent of ROHM Co.,Ltd.

The content specified herein is subject to change for improvement without notice.

The content specified herein is for the purpose of introducing ROHM's products (hereinafter "Products"). If you wish to use any such Product, please be sure to refer to the specifications, which can be obtained from ROHM upon request.

Examples of application circuits, circuit constants and any other information contained herein illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

Great care was taken in ensuring the accuracy of the information specified in this document. However, should you incur any damage arising from any inaccuracy or misprint of such information, ROHM shall bear no responsibility for such damage.

The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM and other parties. ROHM shall bear no responsibility whatsoever for any dispute arising from the use of such technical information.

The Products specified in this document are intended to be used with general-use electronic equipment or devices (such as audio visual equipment, office-automation equipment, communication devices, electronic appliances and amusement devices).

The Products specified in this document are not designed to be radiation tolerant.

While ROHM always makes efforts to enhance the quality and reliability of its Products, a Product may fail or malfunction for a variety of reasons.

Please be sure to implement in your equipment using the Products safety measures to guard against the possibility of physical injury, fire or any other damage caused in the event of the failure of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM shall bear no responsibility whatsoever for your use of any Product outside of the prescribed scope or not in accordance with the instruction manual.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). ROHM shall bear no responsibility in any way for use of any of the Products for the above special purposes. If a Product is intended to be used for any such special purpose, please contact a ROHM sales representative before purchasing.

If you intend to export or ship overseas any Product or technology specified herein that may be controlled under the Foreign Exchange and the Foreign Trade Law, you will be required to obtain a license or permit under the Law.

ROHM SEMICONDUCTOR

Thank you for your accessing to ROHM product informations.
More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/

Общество с ограниченной ответственностью «МосЧип» ИНН 7719860671 / КПП 771901001
Адрес: 105318, г.Москва, ул.Щербаковская д.3, офис 1107

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

http://moschip.ru/get-element

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:
moschip.ru
moschip.ru_4
moschip.ru_6
moschip.ru_9